

Title: **SPIRE FPU and JFETs PFM Mechanical Integration Report**

CI-No: 125 200

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1	24.09.2008	all	Initial issue	

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1 Scope

1.1 Objective

This report describes the mechanical, thermal and electrical integration of the HERSCHEL PFM SPIRE FPU and JFETs onto the optical Bench Plate (OBP).

It summarizes the integration flow, test configuration, integration constraints and step by step process.

All described activities were performed in the ASTRIUM GmbH CR under class 100 cleanliness conditions at Friedrichshafen.

The applicable integration procedure is HP-2-ASED-PR-0083, iss. 1.

2 Documents/Drawings

2.1 Applicable Documents/Drawings

The following documents of the latest issue in effect or as defined herein form a part of this document to the extent specified herein.

AD 1	Mechanical/Thermal Integration of PFM SPIRE FPU & JFETs	HP-2-ASED-PR-0083, iss. 1
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2.2 Reference Documents

N/A

3 Test Report Summary

3.1 Operations

The mechanical, thermal and electrical integration of the SPIRE FPU and JFETs PFM according to HP-2-ASED-PR-0083 onto the optical bench plate and the measurement of the connectors, bonding, isolation was performed according to the procedure as given below.

3.2 Integration Procedure

HP-2-ASED-PR-0083 Issue 1 / Rev. - 10.04.2007 (Red-marked by RAL)

3.3 Integration Readiness Review

HP-2-ASED-MN-1332, IRR for SPIRE FPU PFM, 17.04.07

3.4 Procedure Variations

One Procedure Variations has been raised (instead of fixation bolts with plain shanks, standard screws have been used - see para. 6.1 of as run procedure).

3.5 Non Conformances

The following NCR has been raised:

HP-121000-ASED-NCR-3216 SPIRE FPU FM fixation bolts not according to SPIRE I/F drawing.

Status: closed

3.6 Conclusion

The mechanical, thermal and electrical integration of the SPIRE FPU and JFETs PFM have been performed successfully and are considered ready for the mechanical tests.

The grounding and isolation measurements taken showed all the expected values.

Special care has been taken on ESD constraints during the integration activities.

All steps of the procedure were executed with one procedure variation concerning the fixation bolts as a result of NCR HP-121000-ASED-NCR-3216.

4 AS-RUN Procedure

4.1 Assembly facilities

ASED Integration Centre, Friedrichshafen,
Building IC, clean room class 100

4.2 Assembly dates

Integration on 17.04.2007

4.3 Integration Procedure

Mechanical/Thermal Integration of PFM SPIRE FPU & JFETs
HP-2-ASED-PR-0083
Issue 1 / Rev. - 10.04.2007

4.4 Integration Sequences

The integration sequence has been performed according to step by step procedure in para. 5 of AD1.

4.5 Personal

Operator (ASED)	H. Geiger
Operator mech. (ASED)	K. Reichle
Operator electr. (ASED)	A. Grasl, J. Lang
PA Responsible (ASED)	Th. Schmidt, R. Langenstein

5 Attachment

- AS-RUN Copy of the integration procedure
- Pictures

Title: Mechanical/Thermal Integration of PFM SPIRE FPU & JFETs

CI-No: 125 200

Prepared by: Th. Bayer *Th. Bayer* Date: 12.04.07
Checked by: R. Hohn *R. Hohn* 12.04.07
Engineering: S. Ider *S. Ider* 13.04.07
Product Assurance: R. Stritter *R. Stritter* 15.04.07
Configuration Control: W. Wietbrock *W. Wietbrock* 16.04.07
Project Management: Dr. W. Fricke *W. Fricke* 16/04/2007

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PFM
12.4.07
T. Schmidt
Fricke
31.10.07
R. Hohn

Issue	Date	Sheet	Description of Change	Release
1	10.04. 2007	all	Initial Issue	

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Electrical Integration Procedure*

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1 Scope

This document describes the mechanical and thermal integration activities for the HERSCHEL PFM SPIRE FPU onto the Optical Bench Plate (OBP).

It summarises the nominal integration flow, test configuration, integration constraints, GSE set up and the step by step procedure.

The assembly and quality verification of H/W components be delivered in pre-integrated status will be performed according separate procedures provided by suppliers and are not part of this procedure.

The document is built up as a step by step procedure.

1.1 Objectives

The objective of this procedure is:

- to check all inputs before integration
- to define the self-locking and final torque moments for fasteners
- to provide all parts for defined unit integration
- to integrate the unit according procedure
- to measure the bonding resistance
- to close out the integration/removal activity
- generate the relevant report

1.2 Integration Flow

The integration in coarse steps:

- verify unit Serial-No allocation as defined by System Engineering (if not unique)
- Visual inspection of structure and unit
- Preparation of mechanical set-up and MGSE
- Preparation of components to be integrated or removed (unit, fixation elements, thermal strap, green-/red tag items etc.)
- Determination of mass of items to be integrated
- Preparation of bonding measurement equipment
- Fixation of MGSE to FPU and JFETs
- Removal of detector L0 strap

- Removal from transit base plate
- Integration of FPU and JFETs according step by step instruction onto OBP
- Integration of thermal straps
- Isolation measurement
- Remove of red tag items (e.g. alignment mirror after alignment check)
- Check completeness

2 Documents/Drawings

The following documents of the latest issue in effect or as defined herein form a part of this document to the extent specified herein.

2.1 End Item Data Package

EID 1	SPIRE PFM End Item Data Package	SPIRE-RAL-PRJ-002017
EID 2	OBA	HP-2-SEN-DP-0004

2.2 Applicable Documents

AD 1	SPIRE FPU Handling and Mechanical Integration Procedure	SPIRE-RAL-PRC-002802
AD 2	Making SPIRE ESD Safe	SPIRE-RAL-NOT-002028
AD 3	SPIRE FPU MGSE	DW A1-5264-404-4/5/6/7/8
AD 4	SPIRE Mechanical Interface Drawings P 13 to 26	SPIRE-RAL-DWG-001409
AD 5	L0 Thermal Strap Assembly	DW A1-5264-309A
AD 6	Optical Bench Assembly Drawing	HP-2-ASED-DW-0117-1/2
AD 7	Optical Bench Assembly I/F Drawing	HP-2-ASED-ID-0042-02
AD 8	Optical Bench Assembly I/F Drawing	HP-2-ASED-ID-0042-10
AD 9	Red/Green-Tag Item List for Herschel EPLM	HP-2-ASED-LI-0027
AD 10	PA Plan	HP-2-ASED-PL-0007
AD 11	Contamination Control Plan	HP-2-ASED-PL-0023

2.3 Reference Documents

RD 1	Documentation Identification Procedure and Documentation Management	HP-2-ASED-PR-0001
RD 2	ESD rules for Herschel PLM & S/C Integration Activities	HP-2-ASED-PR-0062

2.4 Abbreviations

For abbreviations see RD 01

3 Configuration

3.1 Initial H/W Configuration

- The PLM will be fixed to the Integration Dolly in upright position (x-direction upwards) under CR 100 conditions.
- The upper CVV bulkhead, upper thermal shields and OBP shield will be removed.
- OBP prepared and ready for integration of SPIRE FPU.
- SPIRE FPU and JFETs placed in clean room class 100 in upright position on an ESD capable table prepared (inclusive temporary grounding strap) and ready for integration.
- Alignment cube is fitted to the FPU (red tag item)
- FPU aperture cover is fitted to the FPU (red tag item)
- Harness between FPU and the JFETs is fitted
- Connectors are covered by safety connectors or black ESD capable dust caps (red tag items)
- MGSE prepared and checked for lifting activities.

3.2 XYZ axis orientation

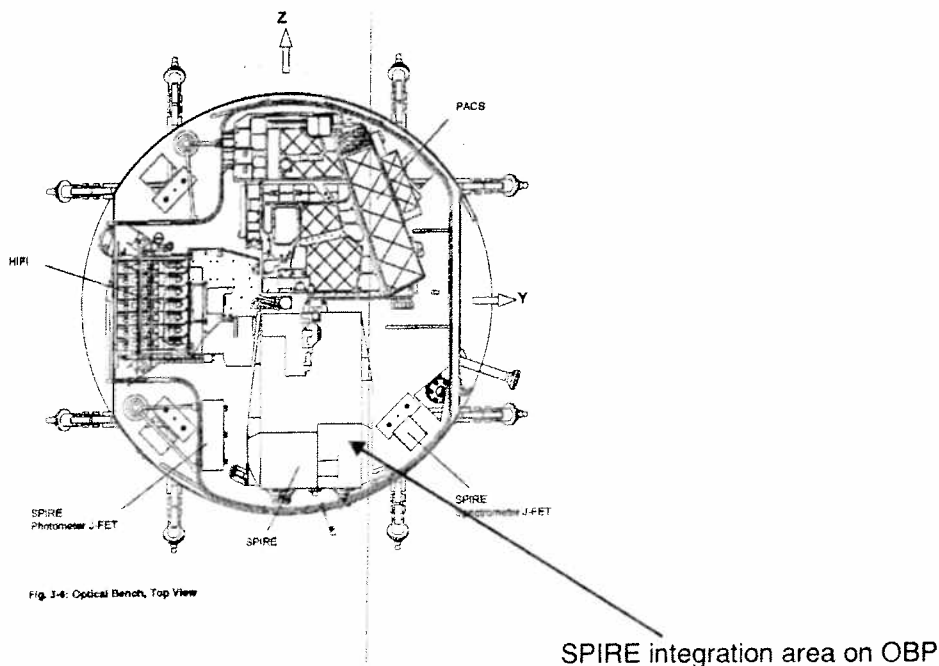


Figure 3.2-1: axis orientation, top view of OBA

4 Conditions

4.1 Personnel

Personnel necessary to complete activities according to this present procedures

Responsibility	Name / Organisation
Operator	*)
Operator	*) <i>Reichte G.</i>
Operator	*) <i>Gerger H.</i>
PA Responsible	*) <i>T. Schmidt / R. Langenstör</i>
Instrument Responsible	*)

*) Names and possible additional personal are to be registered prior to the integration activities.

4.2 Environmental

Cleanliness: class 100
 Temperature: 22°C ± 3°C
 Pressure: ambient
 Rel. humidity: 40 % - 60 %

4.3 General Instructions for Integration of SPIRE FPU & JFETs

The FPU is a delicate optical instrument and should be handled with extreme care at all time. Contamination of the optical surfaces within the instrument is prevented by the aperture cover. This cover should remain in place unless it is necessary to remove it.

WARNING: the bipod legs on two corners of the instrument are very thin section and easily damaged. Care must be taken at all times not to put side loads into these items. These are at risk at all times when the FPU is not attached to a rigid plate. When it is attached to a rigid plate i.e. the OBP or transport plate, then it is tolerant of loads from vibration, lateral expansion, thermal tests....For this reason take care, that the SPIRE FPU need to be settled on distance spacers/auxiliary feet in order not to damage the mounting feet.

4.3.1 *General Safety Requirements, Precautions*

- Respect of the standard technical rules for mechanical and electrical integration and test activities are sufficient.
- Other special hazard precautions are not expected, except for the comments mentioned in the step by step procedure for the relevant item
- The flight H/W has to be handled by authorized personnel only
- During non integration phase the flight H/W has to be protected against contamination by appropriate means like blind flanges, caps or protective foils

The following tasks have to be regarded before start of any integration/test activity:

- IRR has been successfully held to ensure that the relevant procedures, drawings, applicable documents are available, reviewed and approved
- Formal release to start with activity is given by QA
- The necessary GSE and H/W is available, accepted and applicable for use
- Safe working conditions for personnel and H/W are existing and will be applied
- Skilled and authorized personnel is available
- Incoming inspection of H/W have been performed by QA and engineering

4.3.2 *QA Requirements*

QA shall monitor all operations (handlings, transportation and installation) as necessary to assure compliance with this procedure and the applicable sections of the PA Plan (AD 10).

In the course of this procedure QA shall pay particular attention to

- ensure adequate cleanliness conditions
- ensure that all safety aspects are considered
- the application of adequate protections to critical surfaces
- the records in the log sheet
- to ensure that tools and test equipment used is within current calibration cycle

4.3.3 *ESD constraints*

During all handling activities of the SPIRE FPU and JFETs attention must be paid to AD 2 (Making SPIRE ESD safe) and RD 2 (ESD rules for Herschel PLM & S/C Integration Activities)

NOTE: for SPIRE FPU and JFETs:

All the units are sensitive to ESD.

The SPIRE instrument contains very sensitive detectors that are susceptible to damage by Electro static discharge. On delivery all connectors will be protected by covers or shorting plugs as appropriate.

When handling, all personnel shall wear anti static protection (wrist straps or other suitable method).

When the Cryo harness is not connected to the DRCU and the FPU Faraday Shield Link connected to Backshell at the warm end, then the FPU is electrically floating and prone to ESD damage. To avoid this, the FPU should at all time be connected to an electrical ground, when removed from its container and not bagged in dissipative film.

4.4 GSE

All GSE and integration equipment is fit checked and carries valid calibration certificates.

4.4.1 MGSE

Qty.	Designation/Manufacturer	Provided by	Drawing/Ident. NR:	Calibr. Date
	Set of tools	ASED		
	GPHD (general purpose hoisting device)	ASED		
	5 T crane	ASED		
	Torque wrench to cover 1.5 to 8.25 Nm	ASED		
	Allen key, spanners etc	ASED		
	Isopropyl alcohol	ASED		

Table 4.4-1: MGSE

4.4.2 EGSE

Qty.	Designation/Manufacturer	Provided by	Drawing/Ident. NR:	Callbr. Date
	Digital Volt Meter	ASED		
	ESD protection tools	ASED		

Table 4.4-2: EGSE

4.4.3 OGSE

N/A

4.4.4 Special Integration Equipment

Qty.	Designation/Manufacturer	Provided by	Drawing/Ident. NR:	Calibr. Date
	FPU and JFET handling frame.	RAL		
	FPU/JFET/baseplate lifting gear	RAL		
	FPU and JFET lifting and hoisting device	RAL		
	JFET fixation hardware	RAL		
	Isolation washers, special screws and studs	RAL		
	L3 pressure plates 2-off	RAL		
	L1 strap screws M8 2off, M3 4off (these screws will be prepared for wire locking)	RAL		
	Locking wire (for above screws)	RAL		
	L1 bushes for the vent line end	RAL		
	Temporary FPU Grounding Strap including M4 x 6mm fastener to connect to OBP NOTE: Could possibly be attached to the unused harness support bracket holes, or any other convenient tapped hole.	RAL		
	Fixation bolts: <ul style="list-style-type: none"> • FPU M6 12 off • L0 straps M4 16 off • L0 pressure plate 4 off • L3 strap M4 4off 	ASED		

Table 4.4-3: Special Integration Equipment

5 Step by Step Procedure

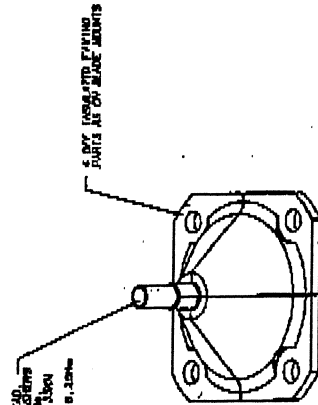
The FPU is supplied with the JFETs and associated harness already fitted. The following tasks need to be carried out before integration onto the OBP. Only standard tools are required at this stage.

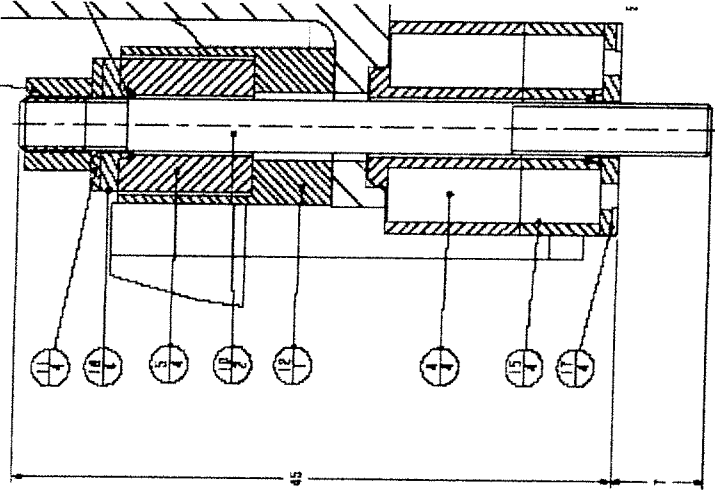
The FPU is supplied with the alignment cube fitted and should be left in place until all alignment activities are complete. It can be removed and replaced within the alignment tolerances required if necessary.

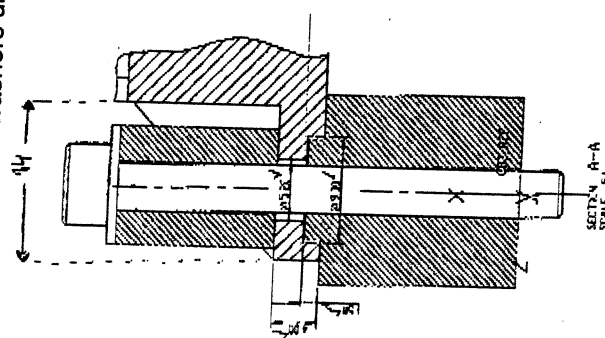
Step- No.	Integration-Step-Description	Nominal Value	Tolerance	Actual Value	Remarks	P	N
5.1.1	Preparation for integration on Optical Bench Plate						
.1	The JFETs will be fitted to the spacecraft together with the FPU. They will need supporting during this activity. The SPIRE supplied MGSE provides provision to support the JFETs during integration.					✓	
.2	The FPU is electrically connected to the baseplate for ESD protection. This strap has to be disconnected from the baseplate and connected directly to secure ground (CVV) for all handling activities of the FPU & JFETs.					✓	
.3	Fit the lifting attachment to the FPU as shown in annex A. Attach the JFETs to the MGSE using lacing cord.				Reichle, Geiger, 17.04.2007	✓	

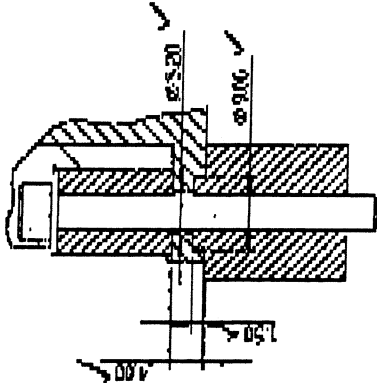
Step- No.	Integration-Step-Description	Nominal Value	Tolerance	Actual Value	Remarks	P	N
5.1.2 Removal from Base Plate							
.1	WARNING: The bipod legs on two corners of the instrument are very thin section CFRP components, and easily damaged. Care must be taken at all times not to put side loads into these items. These are at risk at all times when the FPU is not attached to a rigid plate. Note: All screws that interface to the spacecraft are metric threads.				Reichle 18.04.2007	✓	
.2	Undo the five M4 fasteners which secure the Photometer JFET rack (HSJP; 8 JFETs) to the baseplate. Leave the screws in position as they cannot be removed from the JFET rack.					✓	
.3	Undo the four M4 fasteners that secure the Spectrometer JFET rack (HSJS; 2 JFETs) to the baseplate. Note: Two of these fasteners are studs with nuts on the top, the nuts should be removed and the studs left in place.					✓	
.4	The two remaining L0 straps are also secured to the baseplate. To release these from the baseplate, undo the 4 off M4 fasteners on each strap and remove the fasteners. NOTE: The undersides of these straps form the thermal interface to the HTT pods. Their surfaces are flat and soft gold plated, these surfaces can easily be damaged and the thermal performance of the instrument may suffer as a result.					✓	
.5	Remove the M8 nut from the cone foot, thus leaving the cone on the baseplate.					✓	
.6	Remove the 8 fasteners on the transit blade mounts that attach the FPU to the baseplate.					✓	

Step- No.	Integration-Step-Description	Nominal Value	Tolerance	Actual Value	Remarks	P	N
.7	Lift the FPU and JFETs together from the baseplate by crane.					✓	
.8	In general: Visible check of I/F (no damages, visible clean) before any integration activities				T.Schmidt 18.04.07	✓	
.9	Exchange the transit blade mounts against the flight blade mounts	8.1 Nm	+/- 10% above running torque	8.2 Nm	Will be done by SPIRE team 18.04.07	✓	
.10	Determination of mass of all items to be integrated (screws, washers, thermal straps, FPU & JFETs...)			48,73 kg	Incl. L0 Straps, L1 /L3 I/F bolts & screws	✓	
.11	The FPU and JFETs are now ready for integration.					✓	

Step- No.	Integration-Step-Description	Nominal Value	Tolerance	Actual Value	Remarks	P	N
5.1.3	Mechanical integration of FPU and JFETs onto OBP						
.1	<p>Fix the cone to the OBP using the four M6x21 cap head screws.</p> <p>Note: there are special washers (part number A3/5264/302-3) under the head of each screw and also Vespel insulating bushes (A3/5264/302-2) either side of the mounting flange.</p>  <p style="text-align: center;">DETAIL OF FIXED MOUNTING SCALE 1:1</p>	8.1 Nm	+/- 10% above running torque	8,4 Nm	Cone mounted and torqued by Reichle 18.04.2007	✓	
				R> 20MΩ	Check Isolation of Cone To OBA ≥ 10MΩ Checked by Gras!	✓	

Step- No.	Integration-Step-Description	Nominal Value	Tolerance	Actual Value	Remarks	P	N
.2	<p>Fix the Spectrometer JFET studs (2 off) as indicated on interface drawing 0-KE-0104-360 (p 21 of AD 4). Note: these should be screwed into the OBP until 45mm of stud are protruding from the surface.</p> 	45 mm	+/- 0.5 mm		Geiger 17.04.2007	√	
.3	Lift the FPU and JFETs above the OBP					√	

Step- No.	Integration-Step-Description	Nominal Value	Tolerance	Actual Value	Remarks	P	N
.9	<p>SPiRE JFET Photometer and Spectrometer will be delivered with fixation hardware: Isolation washers, special screws and studs.</p>				The thermal compensators are already mounted on the unit.	✓	
.10	<p>Fit the 5 long bolts to secure the photometer to the OBP. Note that there are washers under the head of each screw.</p> 	2,1 Nm	+/- 10% above running torque	2,2 Nm	18.04.2007 Reichle <i>Check Isolation of JFET Chassis to OBA ≥ 10 MΩ</i>	✓	

Step- No.	Integration-Step-Description	Nominal Value	Tolerance	Actual Value	Remarks	P	N
.11	<p>Fit the two long bolts and two nuts to secure the spectrometer to the OBP. Note that there are washers under the head of each screw.</p>  <p style="text-align: right;">DETAIL 01 SCALE 2:1</p>	2,1 Nm	+/- 10% above running torque	2,2 Nm R> 20MΩ	18.04.2007 Reichle Check Isolation of JFET chassis I/F OBA ≥ 10MΩ Checked by Grasl	✓	✓

Step- No.	Integration-Step-Description	Nominal Value	Tolerance	Actual Value	Remarks	P	N
5.1.4 Integration of thermal links							
.1	L0 straps: <u>The cooler pump and evaporator straps:</u> Ensure that the lower flexible of these two straps align with the pod interfaces. Fit the attachment screws (10 x M4 for the evaporator strap, 6 x M4 screws for the pump).	2.1 Nm	+/- 10% above running torque			✓	
.2	<u>Detector strap:</u> Integration of the strap assembly to the FPU inclusive the Torlon frames according to AD 1, § 6.2.2.2				Will be done by SPIRE team	✓	
.3	Ensure that the lower flexible align with the pod interface. Fit the spreader plate and temperature sensor with the 6 x M4 attachment screws.	2.1 Nm	+/- 10% above running torque			✓	
.4	L1 straps: Fit the two L1 straps to the FPU using at each location, 1 x insulation bush, 1 x Bellville washer type B0750-056-S and 1 x M8 bolt.	10.5 Nm	+/- 10% above running torque	10,5 Nm	See OW 351 Reichle 02.05.2007	✓	
.5	Integrate the 2 x M4 bolts with insulating bushes and 2 x Bellville washers (type B0375-020-S) under each screw head	1.5 Nm	+/- 10% above running torque	1,5 Nm		✓	
.6	On final assembly the M8 fasteners to be wire locked to the M4 fasteners. Screws will be prepared for wire locking				Reichle 02.05.2007	✓	
.7	L3 straps: Fit the two L3 straps to the JFET's using the attachment hardware (L3 thermal strap clamp provided by SPIRE) as shown in interface drawings O-KE-0104-350 and O-KE-0104-360.	2.5 Nm	+/- 10% above running torque	2.5 Nm	See OW 351	✓	

Step- No.	Integration-Step-Description	Nominal Value	Tolerance	Actual Value	Remarks	P	N
5.1.5 Isolation measurement							
.1	General: This test is to be carried out under control of SPIRE team. The removal of the safe plugs from the JFET units places the instrument in a state where it is more susceptible to ESD damage. The process is to be carried out with attention to safe ESD procedures, including the use of ionized air flow over the connectors during mating/demating operations.						
.2	Remove the temporary ground strap between the FPU and the CVV					✓	
.3	FPU/OBP Isolation: Measure and record the electrical isolation between the chassis of the FPU and the OBP.	>= 1 MΩ		>20 MΩ Grasl	Remove of safe plugs and cover with ESD caps accord. to AD 1	✓	
.4	Spect. Det. Box/OBA Isolation: Measure and record the electrical isolation between the detector boxes thermal strap (on the Instrument side of the electrical isolation joint) and the OBP.	>= 1 MΩ		55 KΩ	Due to ESD termination connectors	✓	
.5	Phot. Det. Box/OBP Isolation: Measure and record the electrical isolation between the evaporator thermal strap (on the Instrument side of the electrical isolation joint) and the OBP.	>= 1 MΩ		77 KΩ 02.05.2007 Grasl	Due to ESD termination connectors	✓	
.6	Spect. Det. Box/FPU Isolation: Measure and record the electrical isolation between the detector boxes thermal strap (on the Instrument side of the electrical isolation joint) and the FPU.	>= 1 MΩ		0.3 Ω 02.05.2007 Grasl		✓	

Step- No.	Integration-Step-Description	Nominal Value	Tolerance	Actual Value	Remarks	P	N
.7	Phot. Det. Box/FPU isolation: Measure and record the electrical isolation between the evaporator thermal strap (on the Instrument side of the electrical isolation joint) and the FPU.	$\geq 1 \text{ M}\Omega$		0,3 Ω 02.05.2007 Grasl		✓	
.8	Phot. Det. Box/Spect. Det. Box isolation: Measure and record the electrical isolation between the evaporator thermal strap and the detector boxes thermal strap (both on the Instrument side of the electrical isolation joint). Fix the temporary grounding strap from the FPU to the OBP.	$\geq 1 \text{ M}\Omega$		0,3 Ω 02.05.2007 Grasl		✓	
.9						✓	
.10	Repeat the measurement of the resistance between the OBP and the FPU to ensure that grounding has been successful.	$< 3\Omega$		0,3 Ω 02.05.2007		✓	

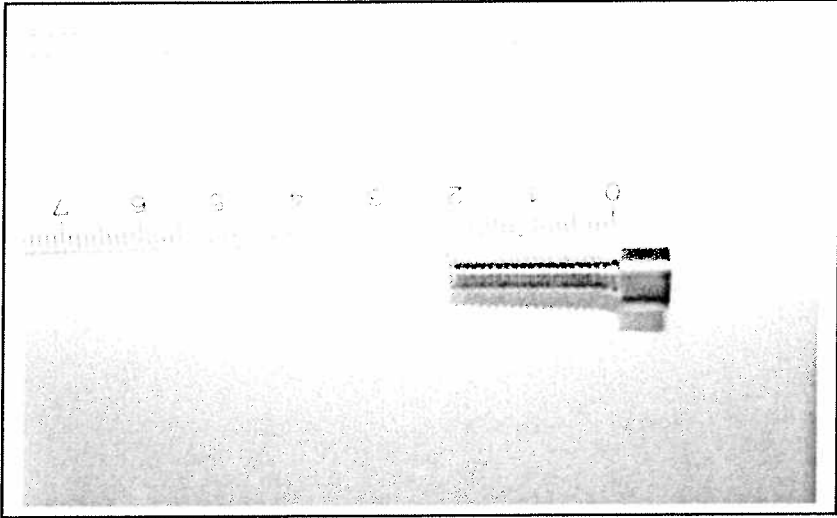
Step- No.	Integration-Step-Description	Nominal Value	Tolerance	Actual Value	Remarks	P	N
5.1.6 Removal of Red Tag items before Integration of Optical Bench shield							
.1	Alignment Cube: Unscrew the three fixing screws and store them with the alignment cube in the "red tag box"				To be removed after alignment activities <i>M.S. OP M. Geiger</i>	✓	
.2	Aperture cover: The aperture cover is removed by unscrewing the four 2-56 UNC (Imperial) cap head screws, which are captive in the cover, and lifting the cover clear.		<i>Removal of 30.10.01 see SD-0192</i>		To be removed at the latest opportunity prior to closure of the Instrument Shield.	✓	
.3	Temporary grounding strap: Removed during the Cryo harness Integration Procedure.					✓	
.4	Shorting plugs: Removed during the Cryo harness Integration Procedure.					✓	
.5	When removed all red tag items shall be bagged and stored in the dedicated "SPIRE red tag box" and mentioned in the Red/Green-Tag Item List for Herschel EPLM (AD 9)	P-2-ASED-LI-0027, Issue 1			<i>30.10.01 P.L.</i>	✓	
.6	There are no Green Tag Items					✓	

Step- No.	Integration-Step-Description	Nominal Value	Tolerance	Actual Value	Remarks	P	N
5.1.7 Final visual inspection							
.1	Visual inspection of the SPIRE FPU & JFETs, with regard to damages and visible contamination.	No damages, visible clean			* 30.10.01	✓	
.2	Visual inspection of the mounting of the feet and of the thermal links to the SPIRE FPU, with regard to damages and visible contamination	No damages, visible clean			* 30.10.01	✓	
.3	Visual inspection of the electrical connectors to the SPIRE FPU, with regard to damages and visible contamination	No damages, visible clean			* 30.10.01	✓	
.4	Check that all Red Tag Items are dismantled prior to closure of optical bench with optical bench shield.			see SD-0192	30-10-01	✓	
.5	MIP				30-10-01	✓	

* Final inspection of ESA + TAS-F 30.10.01 see log book
 Annex 1 : Electrical Integration Procedure SPE2E-RAL-PRC-002882 Iss. 2

6 Summary Sheets

6.1 Procedure Variation Summary

	Test Change		Curr. No.:	
			Date:	
			Page 1	of
Test designation		Test Procedure	Issue	Rev.
Mechanical integration		HP-2-ASED-PR-0083	1	
Test step changed		Reason for Change:		
4.4.4. Fixation bolts FPU M6		Discrepancy between IRD-A and IRD-B		
<p>It has been agreed by all parties see HP-121000-ASED-NC- 3216 NRB disposition that for the FPU M6 fixation bolts with plain shanks as requested by drawing number SPIRE INTERFACE 5264 300 sheet 4 (see Detail of blade mount fixings) Standard screws ISO 4762 M6 x 21mm A2-70 with a 3.1B material certificate without plain shank will be used.</p>				
				
Prepared by:		Resp. Test Leader	Project Engineer	
PA/QA				

6.2 Non Conformance Report (NCR) Summary

Status list of applicable NCR to be attached

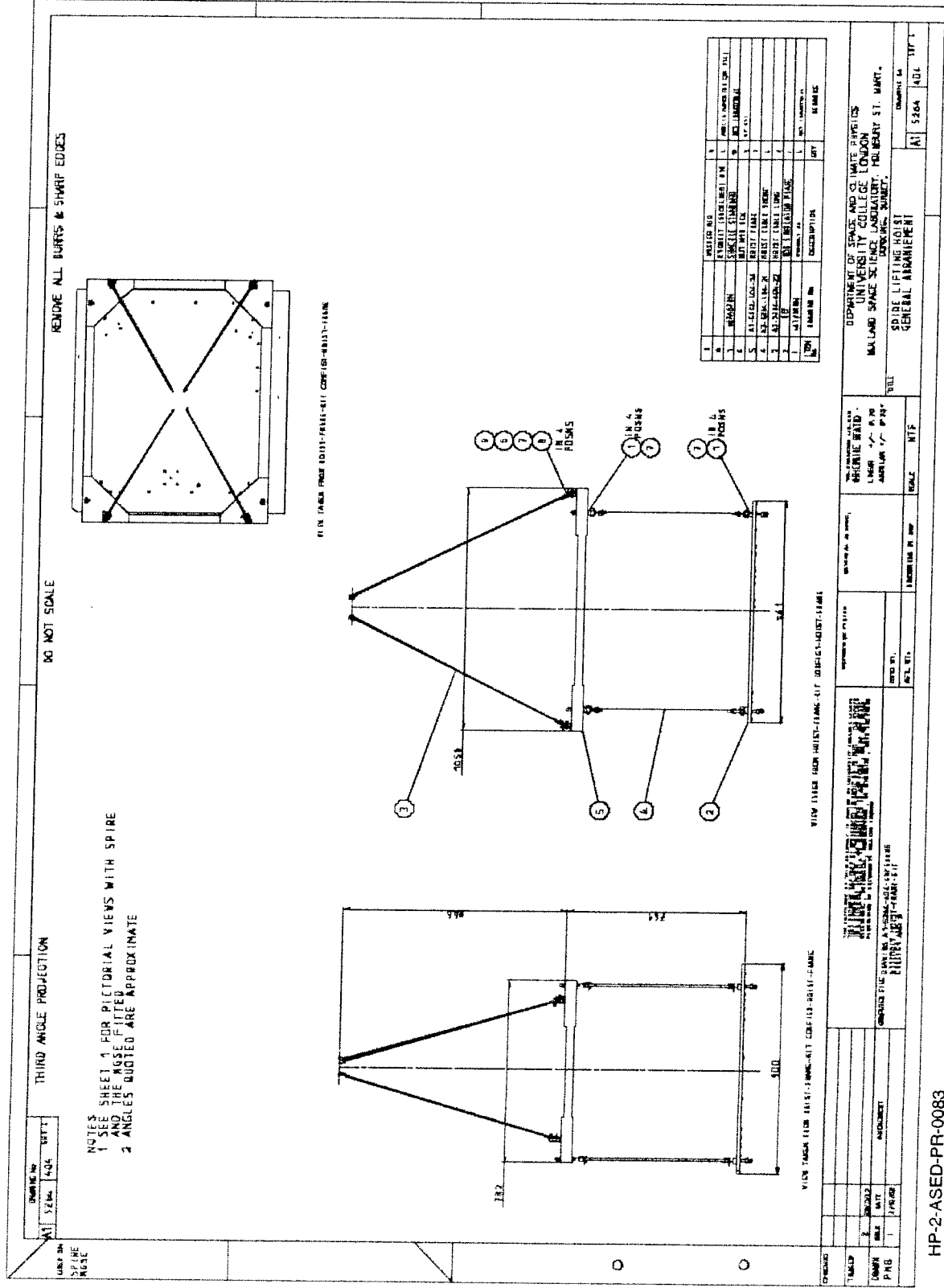
NCR - No.	NCR - Title	Date	Open Closed	PA sig.
HP-121000-ASED- NCR-3216	SPIRE FPU FM fixation bolts not according to SPIRE I/F drawing	18.04.2007	closed	

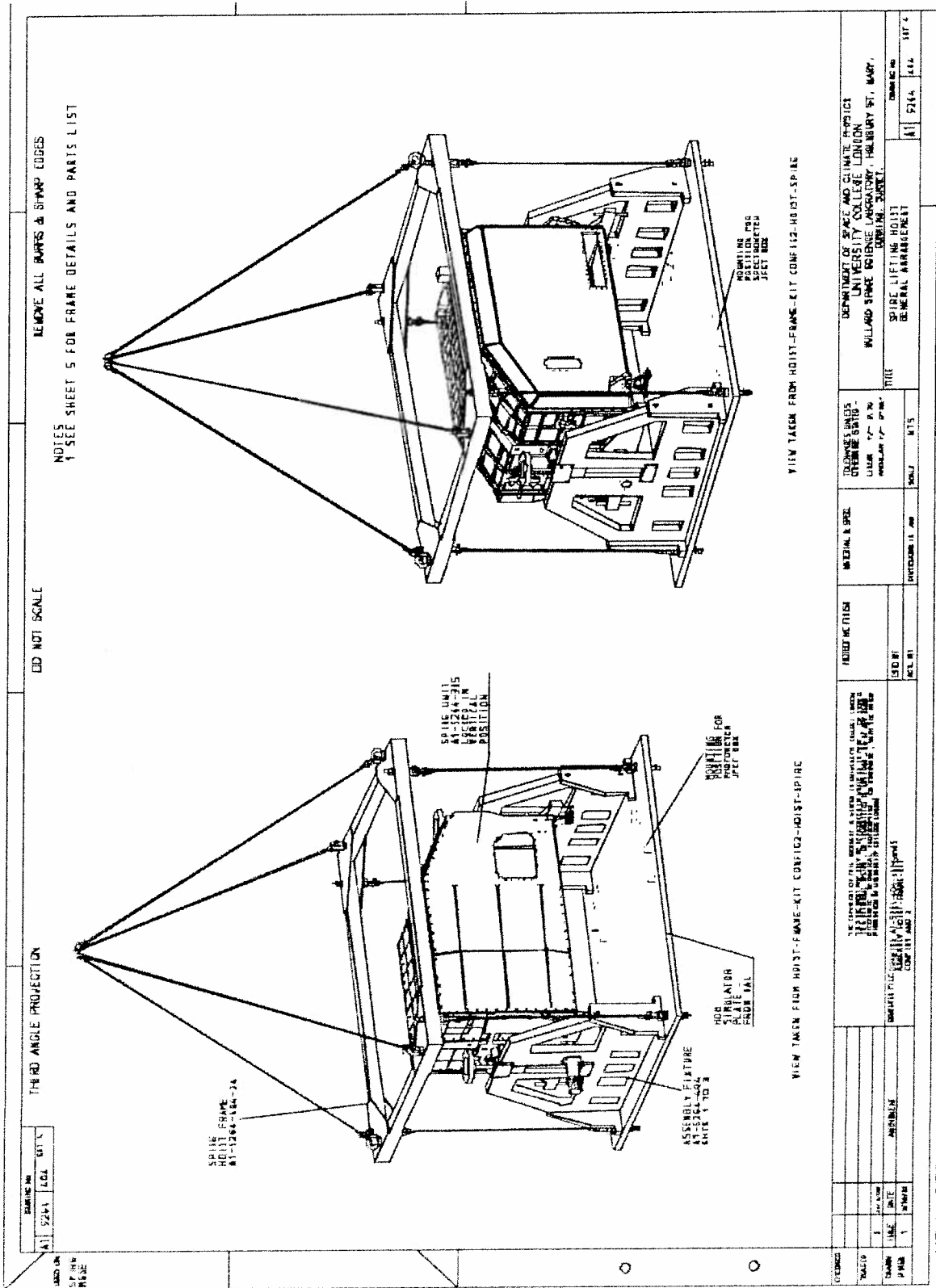
6.3 Sign-off Sheet

	Date	Signature
Integration Manager	31.10.07	<i>[Signature]</i>
Operator	31.10.07	<i>[Signature]</i>
PA Responsible	31.10.07	<i>[Signature]</i>

7 ANNEX A

7.1 DRAWINGS OF SPIRE FPU MGSE



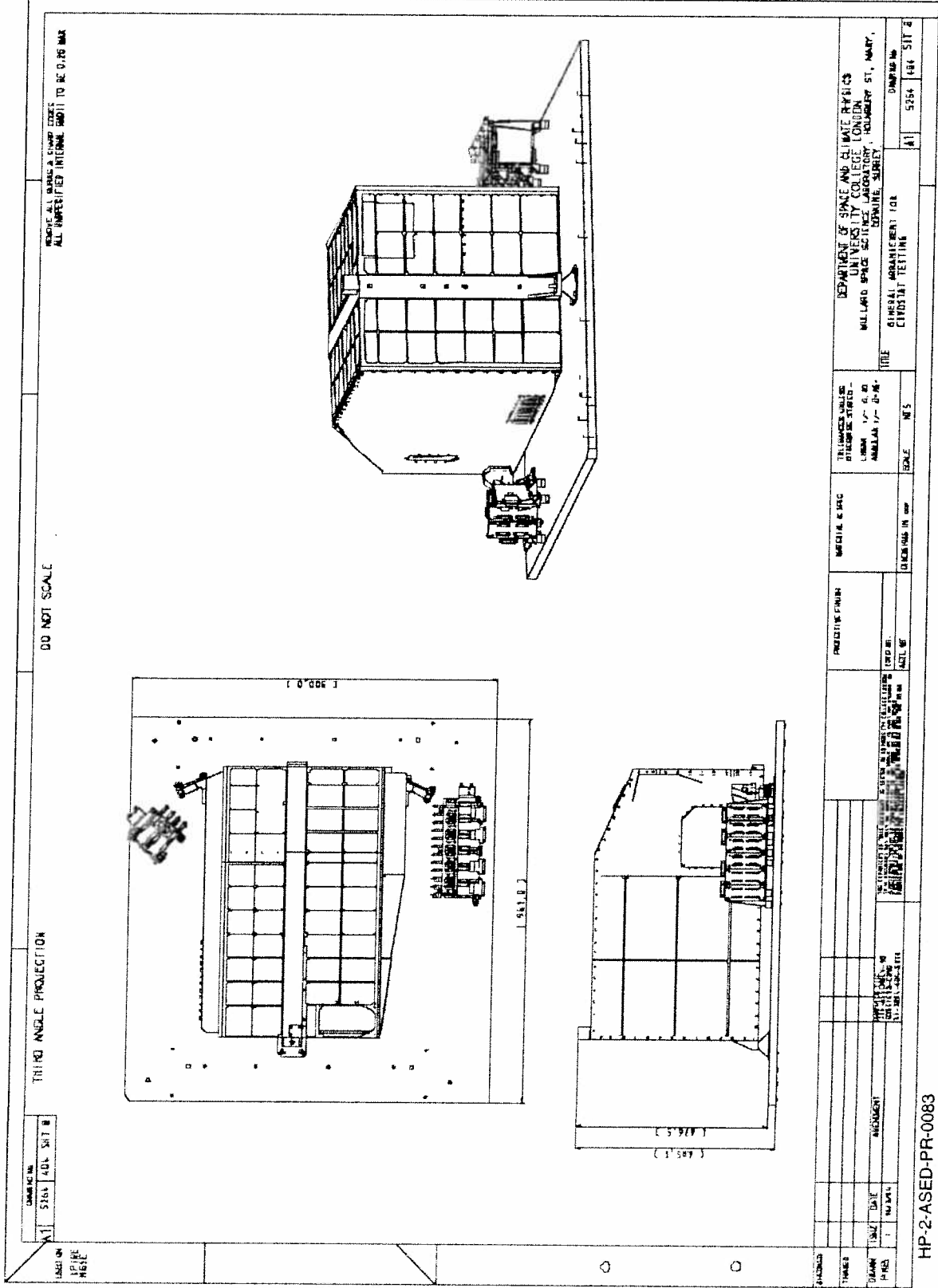


Doc. No: HP-2-ASED-PR-0083

Issue: 1

Date: 10.04.07

File: HP-2-ASED-PR-0083_1.as SPIRE.doc



RENDER ALL SURFACES A SHARP EDGE
ALL UNPECIFIED INTERNAL FINISH TO BE 0.450 MAX

DO NOT SCALE

THIRD ANGLE PROJECTION

CONTRACT NO.	ADL SKT B
A1	5264

BASED ON
SPIRE
RELE

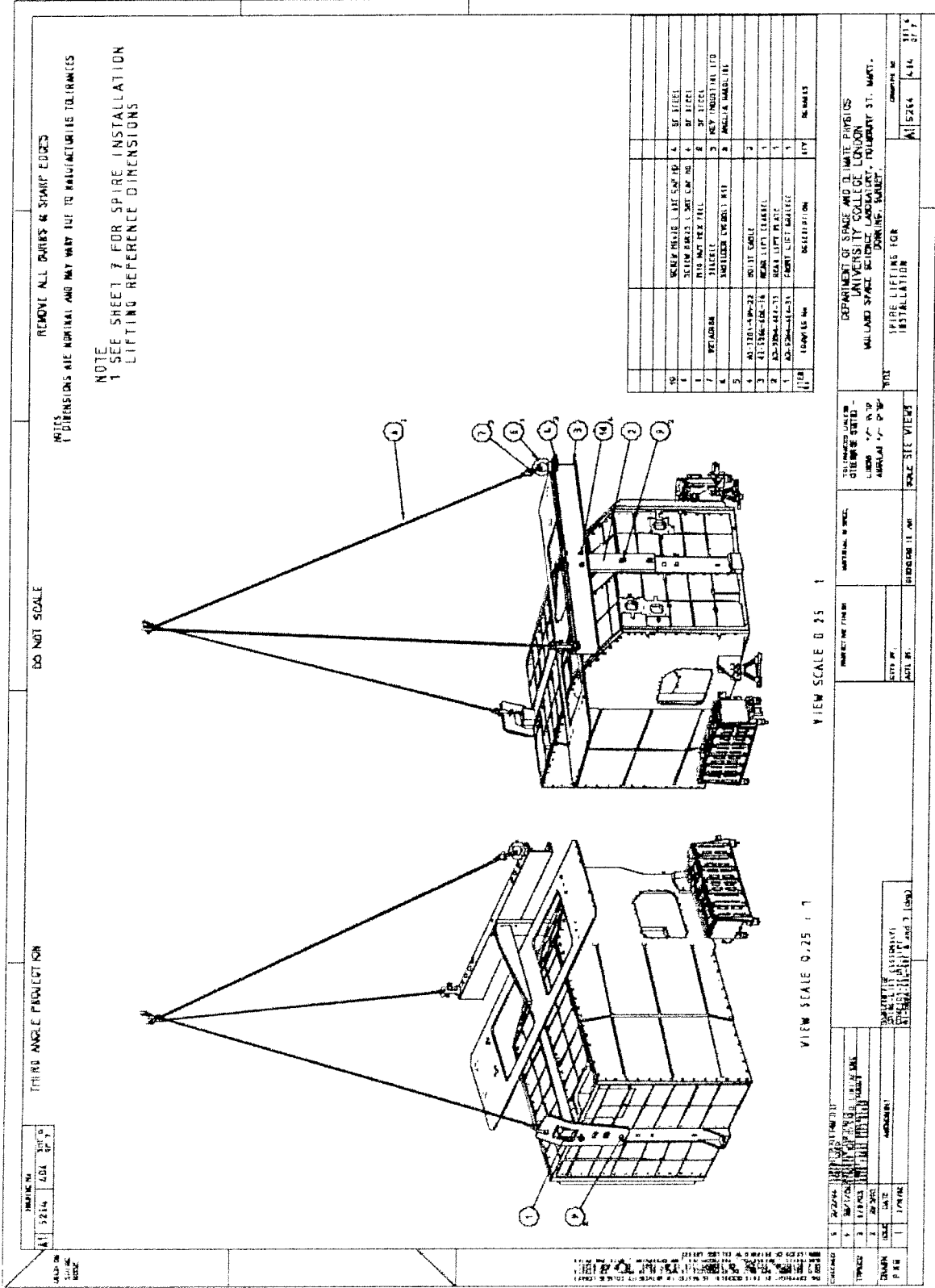
DESIGNED BY	DATE	SCALE	NO. OF SHEETS	TOTAL NO. OF SHEETS
DRAWN BY	DATE	SCALE	NO. OF SHEETS	TOTAL NO. OF SHEETS
CHECKED BY	DATE	SCALE	NO. OF SHEETS	TOTAL NO. OF SHEETS
APPROVED BY	DATE	SCALE	NO. OF SHEETS	TOTAL NO. OF SHEETS
DEPARTMENT OF SPACE AND CLIMATE PHYSICS UNIVERSITY COLLEGE LONDON MILLARD BRICE SCIENCE LABORATORY, HOLMBURY ST, MARY, CROFTON, SURREY TITLE: HERSCHEL (MIRACLES) TOR DRAWING NO: 5264 184 SIT B				

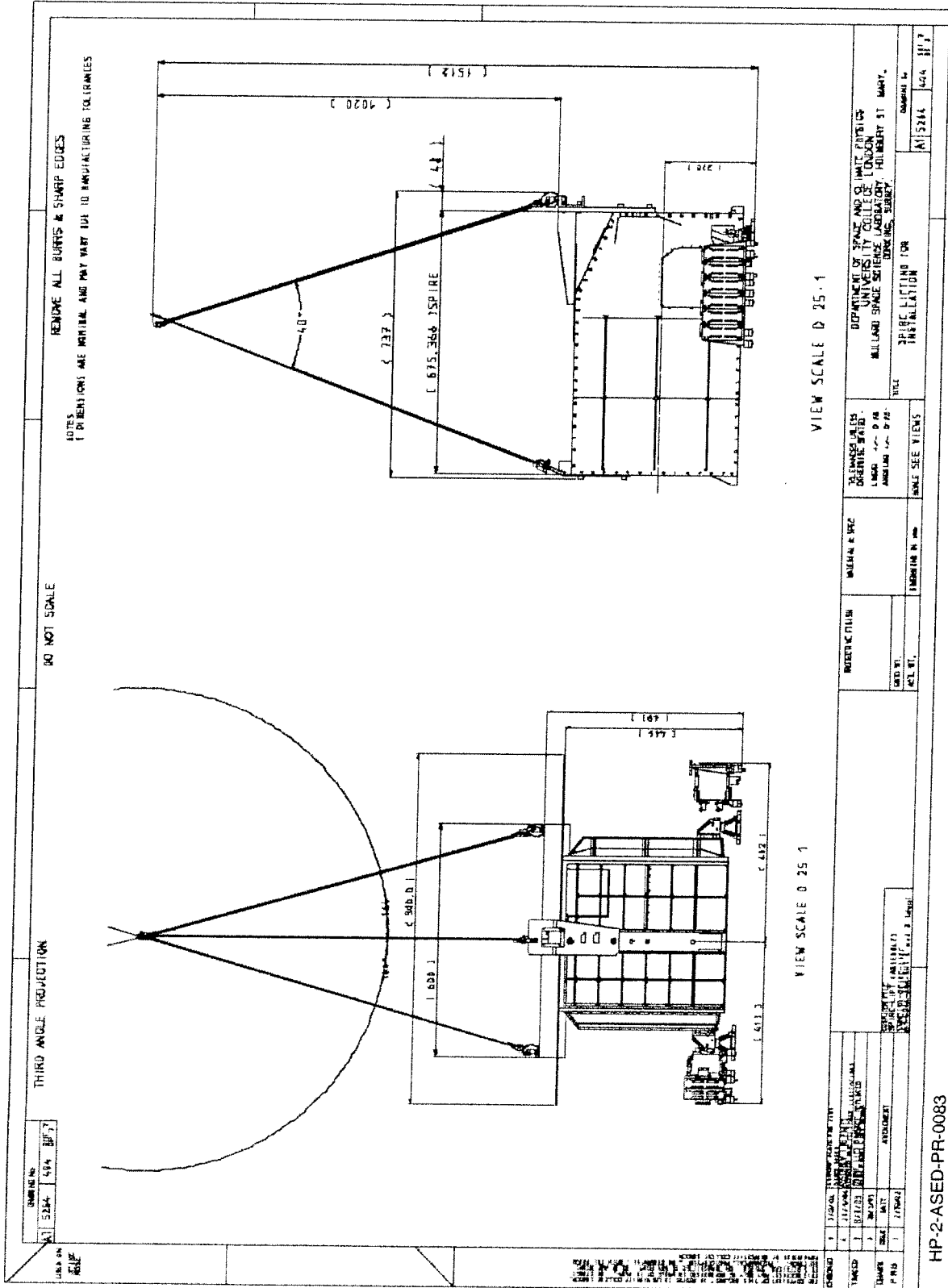
Doc. No: HP-2-ASED-PR-0083

1

Issue:

Date: 10.04.07





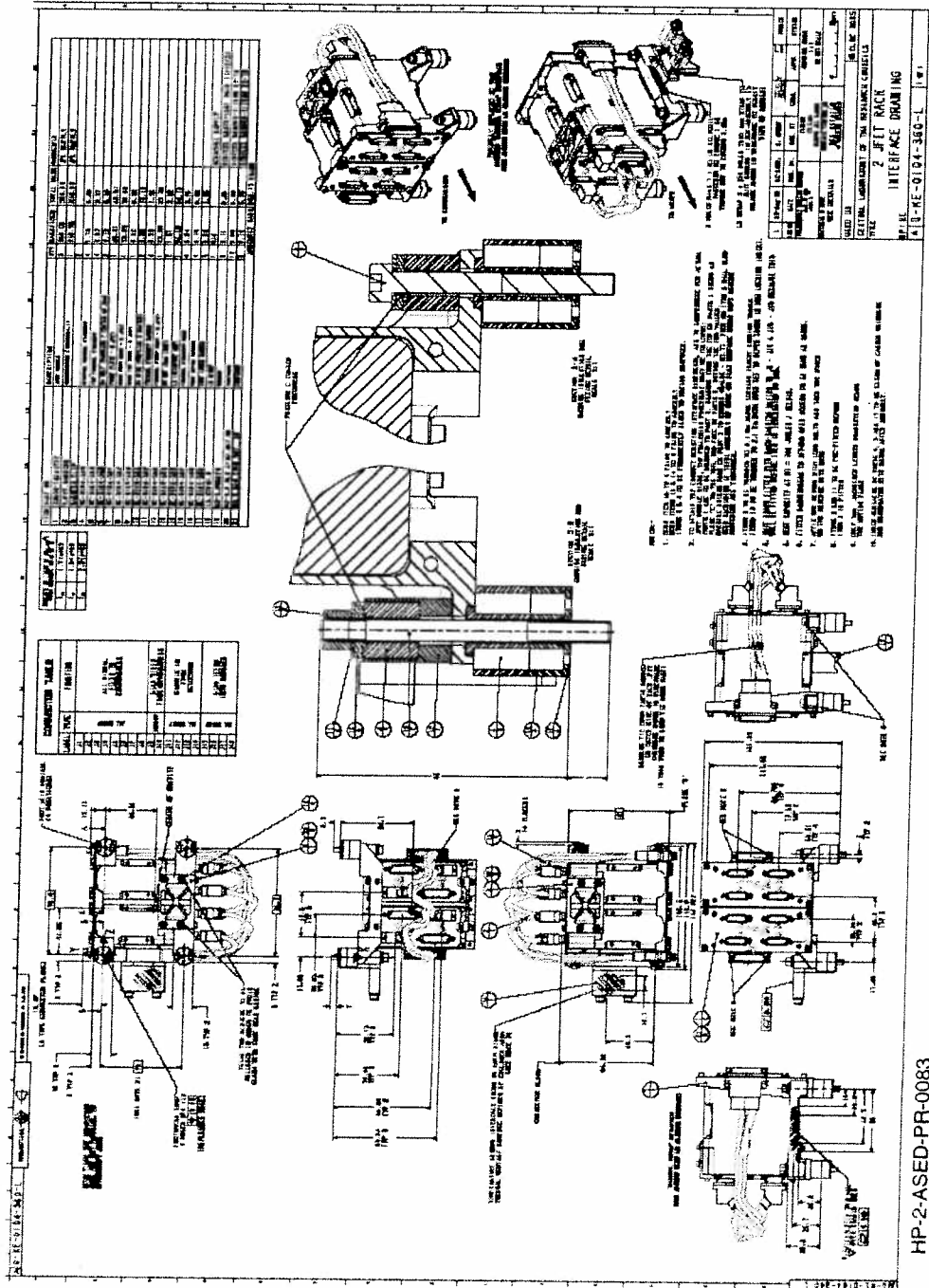
Doc. No: HP-2-ASED-PR-0083

Issue: 1

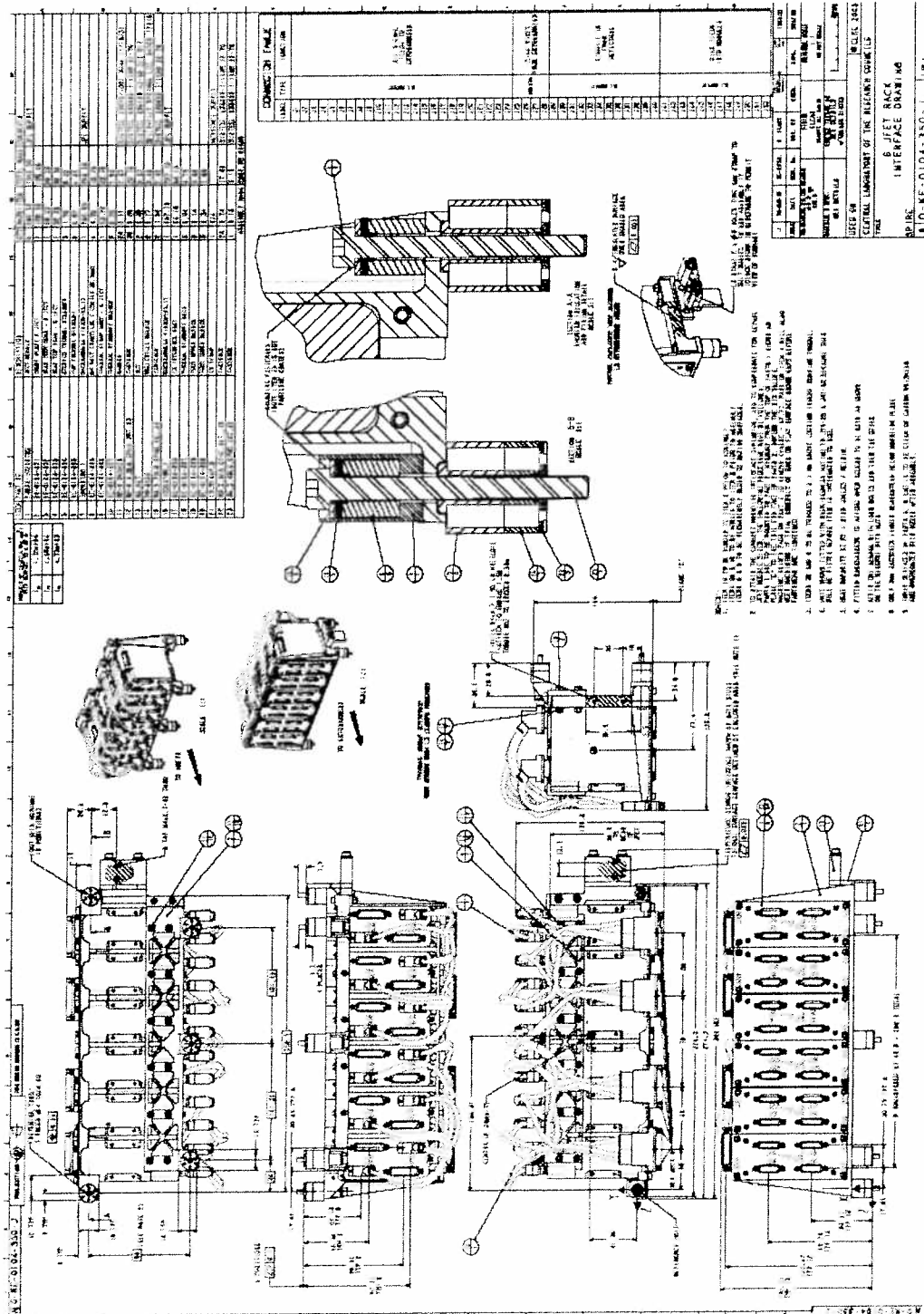
Date: 10.04.07

9 ANNEX C

9.1 Spectrometer I/F drawing



9.2 Photometer I/F drawing



END OF DOCUMENT

	Name	Dep./Comp.		Name	Dep./Comp.
	Alberti von Mathias Dr.	ASG23		Schuler Günter	ASA42
	Baldock Richard	FAE12		Schweickert Gunn	ASG23
X	Barlage Bernhard	AED13		Sonn Nico	ASG51
X	Bayer Thomas	ASA42		Steininger Eric	AED32
	Brune Holger	ASA45	X	Stritter Rene	AED11
	Edelhoff Dirk	AED2	X	Suess Rudi	OTN/ASA44
	Fehringer Alexander	ASG13		Theunissen Martijn	DSSA
X	Fricke Wolfgang Dr.	AED 65		Wagner Klaus	ASG23
X	Geiger Hermann	ASA42	X	Wietbrock Walter	AET12
X	Grasl Andreas	OTN/ASA44		Wöhler Hans	ASG23
X	Grasshoff Brigitte	AET12	X	Wössner Ulrich	ASE252
	Hamer Simon	Terma			
X	Hendry David	Terma			
X	Hengstler Reinhold	ASA42			
	Hinger Jürgen	ASG23			
X	Hohn Rüdiger	AED65			
	Hölzle Edgar Dr.	AED32			
	Huber Johann	ASA42			
X	Hund Walter	ASE252			
X	Idler Siegmund	AED312			
	Ivány von András	FAE12			
	Jahn Gerd Dr.	ASG23			
	Kalde Clemens	ASM2			
	Kameter Rudolf	OTN/ASA42			
X	Kettner Bernhard	AET42			
	Knoblauch August	AET32	X	Alcatel Alenia Space Cannes	AAS-F
	Koelle Markus	ASA43		Alcatel Alenia Space Torino	AAS-I
	Koppe Axel	AED312	X	ESA/ESTEC	ESA
X	Kroeker Jürgen	AED65			
	La Gioia Valentina	Terma		Instruments:	
X	Lang Jürgen	ASE252		MPE (PACS)	MPE
X	Langenstein Rolf	AED15	X	RAL (SPIRE)	RAL
	Langfermann Michael	ASA41		SRON (HIFI)	SRON
	Martin Olivier	ASA43			
	Maukisch Jan	ASA43			
	Much Christoph	ASA43		Subcontractors:	
	Müller Jörg	ASA42		Alcatel Alenia Space Antwerp	ABSP
X	Müller Martin	ASA43		Austrian Aerospace	AAE
	Peltz Heinz-Willi	ASG13		Austrian Aerospace	AAEM
	Pietroboni Karin	AED65		BOC Edwards	BOCE
	Platzer Wilhelm	AED2		Dutch Space Solar Arrays	DSSA
X	Reichle Konrad	ASA42		EADS Astrium Sub-Subsyst. & Equipment	ASSE
	Runge Axel	OTN/ASA44		EADS CASA Espacio	CASA
X	Schink Dietmar	AED32		EADS CASA Espacio	ECAS
	Schlosser Christian	OTN/ASA44		European Test Services	ETS
	Schmidt Rudolf	FAE12		Patria New Technologies Oy	PANT
X	Schmidt Thomas	AED15		SENER Ingenieria SA	SEN

HP-2-RAL-PR-0017_2_0

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SPIRE

AS
28.4.2007
T. Schmidt
Finished 31-10-07
P. B.

SUBJECT: SPIRE PFM SIH ELECTRICAL INTEGRATION PROCEDURE

PREPARED BY: Douglas Griffin

UPDATED BY: J. Lang

DOCUMENT No: SPIRE-RAL-PRC-002882

ISSUE: 2.0

Date: 18.04.2007

CHECKED BY: E. Sawyer

Date: *E. Sawyer*

APPROVED BY :

ASED-Eng.: J. Lang

Date: 18.4.07

ASED-PA: R. Stritter

Date: 18.4.07

ASED-AIT: M. Müller

Date: 18.4.07

RAL-E.Sawyer

Date: 18-4-07

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Change Record

ISSUE	DATE	
1.0	12-04-2007	Initial release -
2.0	18-04-2007	ASED update

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3.1 PREREQUISITES.....	5
3.2 NOTES:.....	5
3.3 DETAILED STEP-BY-STEP PROCEDURE	6
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1. APPLICABLE/REFERENCE DOCUMENTS

Number	TITLE	Document Number	Issue
AD 1	SPIRE FPU Handling and Mechanical Integration Procedure	SPIRE-RAL-PRC-002802	2
AD 2	Making SPIRE ESD Safe	SPIRE-RAL-NOT-002028	2
AD 3	SPIRE FM Warm Functional Test Procedures	SPIRE-RAL-PRC-2422	2.2
AD 4	ESD-Rules for Herschel PLM & Integration Activities	HP-2-ASED-PR-0062	1

Number	TITLE	Document Number	Issue
RD1	Email: Instruments El. Integration Flow (See §4 Appendix 1 – EADS Integration Sequence Email)	NA	NA
RD2	Cryo Harness Interconnection Diagram SPIRE (PFM)	2547-121430-030-01-0B	B
RD3	Cryo-Harness Interconnection Diagram SPIRE (PFM)	HP-2-ASED-ID-0091-01-0B	B
RD4	PFM CVV int SPIRE SIH Integration	HP-2-ASED-TP-0050	1

2. SCOPE AND INTRODUCTION

This document establishes the detailed procedure to be followed for the electrical integration of the SIH to the SPIRE FPU, JFP and JFS. It also covers the mating of the SIH-CS-01 to -13 harnesses to the CVV-FTHR connectors 211121 J22 to J34. As outlined in RD 1 (see Appendix 1).

The incorporation of the measurement of the balance of Idd and Iss for the JFET modules is a result of the fact that an extra propagating failure mechanism was discovered during the SPIRE PFM-4 ILT campaign. It is a diagnostic test of the integrity of the entire SPIRE detector system in the warm condition. The chronological SIH connector mating and fixation in final flight configuration and its inspections need, have been edit in the step-by-step procedure too. The final CVV internal inspection to be performed by ASED , Alcatel & ESA after the SPIRE cold-unit and SIH electrical integration is covered here in too.

3. MATING OF SIH-CS-01 TO -13 TO FPU, JFP AND JFS

3.1 Prerequisites

1. The FPU, JFP and JFS are mechanically integrated to the OBA as detailed in AD 1, §6.2.1 through §6.2.4
2. The SIH-CS-XX harnesses have been integrated into the cryostat

3.2 Notes:

1. The Isolation Test detailed in AD 1, §6.2.5 (Isolation Test) is to be completed during the first stage of the procedure. The results must be compliant with the specified pass criteria for the integration to continue.
2. The FPU, JFP and JFS are ESD sensitive. Handling of these units is to be carried out by personnel suitably trained and equipped. Prior to carrying out the mating operations detailed below, the Pxx and Jxx connectors are to put in an ionized air stream for > 30 sec to discharge the harness.
3. The connector mating operations detailed below are to be recorded in the relevant sections of the paper PFM SPIRE EIDP
4. Red tag items removed from the FPU and JFET modules (safeing plugs and ESD caps to be placed in the SPIRE red tag box and stored in the SPIRE transport container)

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No:	Activity	Remarks/Results	Sign off
8	Remove and store ESD cover from FPU 121100 J23 Mate FPU SIH 121100 P23 (Prime thermometry) Perform torque of 0,33 Nm	Identify removed cold-unit connector shorting-plugs as RED-TAG item & store it in subject cubboard. Visual inspection of FPU connectors and vacuum cleaning carried out at this stage.	✓
9	Remove and store ESD cover from FPU 121100 J24 Inspect FPU J24 jackpost threads Mate FPU SIH 121100 P24 (Red. thermometry) Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm Check SIH connector fixation bolts are fit to end, else lock with EC2216		✓
10	Remove and store ESD cover from FPU J19 Mate FPU SIH 121100 P19 (Prime cooler) Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓
11	Remove and store ESD cover from FPU 121100 J20 Inspect FPU J20 jackpost threads Mate FPU SIH 121100 P20 (Red. cooler) Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm Check SIH connector fixation bolts are fit to end, else lock with EC2216		✓
12	Remove and store ESD cover from FPU 121100 J25 Inspect FPU J25 jackpost threads Mate FPU SIH 121100 P25 (Prime BSM) Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm Check SIH connector fixation bolts are fit to end, else lock with EC2216		✓

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3.3 Detailed Step-by-step Procedure Carried out on 19/4/07

No:	Activity	Remarks/Results	Sign off
	Grounding check		
1	Carry out the activities in AD 1, §6.2.5	FPU / OBA: Spect. Det. Box / OBA: Phot. Det. Box / OBA: Spect. Det. Box / FPU: Phot. Det. Box / FPU: Phot. Det. Box / Spect. Det. Box:	OC OC OC OC OC OC
2	Remove the ESD covers from the JFP 121210 J25 through JFP J28 and remate the Type-III safeing plugs	Identify removed cold-unit connector-covers as RED-TAG Item & store it in subject cubboard Note, debris found in JFP J25, removed mechanically and vacuum cleaner	✓
	Mating of FPU SIH	The connector codes shall be defined, because E-PLM mationg / Demating DB updates	
3	Detailed inspection be performed on FPU J20, J22, J24 & J25 for properly tight screw-lock assies, else fixation bolts to be locally stopped by use of EC2216	(HP-2-ASED-NC-1340)	✓
4	Verify that SPIRE Safeing Plug Type-VIII is mated to CVV FTNR 211121 J30. If not installed, then mate	Take Saving-plugs from RED-TAG Item cubboard & record removal	✓
5	Verify that SPIRE Safeing Plug Type-VIII is mated to CVV FTNR 211121 J29. If not installed, then mate	Take Saving-plugs from RED-TAG Item cubboard & record removal	✓
6	Verify that SPIRE Safeing Plug Type-VII is mated CVV FTNR 211121 J34. If not installed, then mate	Take Saving-plugs from RED-TAG Item cubboard & record removal	✓
7	Verify that SPIRE Safeing Plug Type-VII is mated to SVM-CB 312300 J05 CVV FTNR 211121 J33. If not installed, then mate	Take Saving-plugs from RED-TAG Item cubboard & record removal	✓

No:	Activity	Remarks/Results	Sign off
13	Remove and store ESD cover from FPU 121100 J26 Mate FPU SIH 121100 P26 (Red. BSM) Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		√
14	Remove and store ESD cover from FPU 121100 J21 Mate FPU SIH 121100 P21 (Prime S-Cal) Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		√
15	Remove and store ESD cover from FPU 121100 J22 Inspect FPU J22 jackpost threads Mate FPU SIH 121100 P22 (Red. S-Cal) Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm Check SIH connector fixation bolts are fit to end, else lock with EC2216		√
16	Remove and store safeing plug from FPU 121100 J29 Mate FPU SIH 121100 P21 (Prime SMEC) Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		7M ohm due to safe plug in J30
17	Remove and store safeing plug from FPU 121100 J30 Mate FPU SIH 121100 P30 (Red. SMEC) Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		7M ohm due to safe plug in J30
18	Remove and store safeing plug from FPU 121100 J27 Mate FPU SIH 121100 P27 (Prime SMEC) Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		7M ohm due to safe plug in J30
19	Remove and store safeing plug from FPU 121100 J28 Mate FPU SIH 121100 P28 (Red. SMEC) Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		7M ohm due to safe plug in J30

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No:	Activity	Remarks/Results	Sign off
	Mating of JFS (Spectrometer) SIH		
20	Verify that SPIRE Safeing Plug Type-VI is mated to CVV FTTHR 211121 J32. If not installed, then mate	Take Saving-plugs from RED-TAG item cupboard & record removal	✓
21	Verify that SPIRE Safeing Plug Type-VII is mated to CVV FTTHR 211121 J31. If not installed, then mate	Take Saving-plugs from RED-TAG item cupboard & record removal	✓
22	Remove SPIRE Safeing Plug Type-III from JFS 121220 J09	Inspection of all JFS connectors carried out at this point	✓
23	Mate JFS SIH 121220 P09 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0.33 Nm	Short, remove P09, fit P10 OK, Try P09 again, >1M	
24	Remove SPIRE Safeing Plug Type-III from JFS 121220 J10		473K with safing plug J32
25	Mate JFS SIH 121220 P10 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0.33 Nm		
26	Remove and store ESD cover from JFS 121220 J07 Mate JFS SIH 121220 P07 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0.33 Nm		✓
27	Remove and store ESD cover from JFS J05 Mate JFS SIH 121220 P05 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0.33 Nm		✓
28	Remove and store ESD cover from JFS 121220 J06 Mate JFS P06 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0.33 Nm		✓

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No:	Activity	Remarks/Results	Sign off
29	Remove and store ESD cover from JFS 121220 J02 Mate JFS SIH 121220 P02 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		√
30	Remove and store ESD cover from JFS 121220 J01 Mate JFS SIH 121220 P01 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		√
31	Remove and store ESD cover from JFS 121220 J03 Mate JFS SIH 121220 P03 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		√
32	Remove and store ESD cover from JFS 121220 J04 Mate JFS SIH 121220 P04 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		√
33	Verify that 312300 J1 and J02 Launch-latches are integrated.	N/A for CVVint Integration	
	Mating of JFP SIH (Photometer)		
34	Verify that SPIRE Safeing Plug Type-V is mated to CVV FTHR 211121 J26. If not installed, then mate		√
35	Verify that SPIRE Safeing Plug Type-VII is mated to CVV FTHR 211121 J22. If not installed, then mate		√
36	Verify that SPIRE Safeing Plug Type-VII is mated to CVV FTHR 211121 J23. If not installed, then mate		√
37	Verify that SPIRE Safeing Plug Type-VII is mated to CVV FTHR 211121 J24. If not installed, then mate		√
38	Verify that SPIRE Safeing Plug Type-VII is mated to CVV FTHR 211121 J25. If not installed, then mate		√

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No:	Activity	Remarks/Results	Sign off
39	Verify that SPIRE Safeing Plug Type-VII is mated to CVV FTHR 211121 J27. If not installed, then mate		✓
40	Verify that SPIRE Safeing Plug Type-VII is mated to CVV FTHR 211121 J28. If not installed, then mate		✓
41	Verify that 312100 J1A and J1B links are integrated.	N/A for CVVint Integration	
42	Remove and store SPIRE Safeing Plug Type-III from JFP 121210 J25 Mate JFP SIH 121210 P25 to J25	Store Saving-plugs in RED-TAG Item cubboard	✓
43	Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓
44	Remove and store SPIRE Safeing Plug Type-III from JFP 121210 J27 Mate JFP SIH 121210 P27 to J27	Store Saving-plugs in RED-TAG Item cubboard	✓
45	Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓
46	Remove and store SPIRE Safeing Plug Type-III from JFP 121210 J26 Mate JFP SIH 121210 P26 to J26	Store Saving-plugs in RED-TAG Item cubboard	✓
47	Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓
48	Remove and store SPIRE Safeing Plug Type-III from JFP 121210 J28 Mate JFP SIH 121210 P28 to J28	Store Saving-plugs in RED-TAG Item cubboard	✓
49	Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓
50	Remove and store ESD cover from JFP121210 J16 Mate JFP SIH 121210 P16 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		55K due to safe plugs

No:	Activity	Remarks/Results	Sign off
51	Remove and store ESD cover from JFP 121210 J15 Mate JFP SIH 121210 P15 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓
52	Remove and store ESD cover from JFP 121210 J13 Mate JFP SIH 121210 P13 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓
53	Remove and store ESD cover from JFP 121210 J14 Mate JFP P14 Perform torque of 0,33 Nm		✓
54	Remove and store ESD cover from JFP 121210 J18 Mate JFP SIH 121210 P18 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓
55	Remove and store ESD cover from JFP 121210 J17 Mate JFP P17 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓
56	Remove and store ESD cover from JFP 121210 J21 Mate JFP SIH 121210 P21 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm	Disconnected and reconnected to reroute harness	✓✓
57	Remove and store ESD cover from JFP 121210 J22 Mate JFP SIH 121210 P22 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓

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No:	Activity	Remarks/Results	Sign off
58	Remove and store ESD cover from JFP 121210 J24 Mate JFP SIH 121210 P24 Measuere FPU Isolation Resistance to OBA structure [R > 1MΩ] Measuere FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓
59	Remove and store ESD cover from JFP 121210 J23 Mate JFP P23 Measuere FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓
60	Remove and store ESD cover from JFP 121210 J19 Mate JFP SIH 121210 P19 Measuere FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓
61	Remove and store ESD cover from JFP 121210 J20 Mate JFP SIH 121210 P20 Measuere FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓
62	Remove and store ESD cover from JFP 121210 J02 Mate JFP SIH 121210 P02 Measuere FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓
63	Remove and store ESD cover from JFP 121210 J01 Mate JFP SIH 121210 P01 Measuere FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓
64	Remove and store ESD cover from JFP 121210 J05 Mate JFP SIH 121210 P05 Measuere FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓

No:	Activity	Remarks/Results	Sign off
65	Remove and store ESD cover from JFP 121210 J06 Mate JFP SIH 121210 P06 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓
66	Remove and store ESD cover from JFP 121210 J10 Mate JFP SIH 121210 P10 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓
67	Remove and store ESD cover from JFP 121210 J09 Mate JFP P09 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓
68	Remove and store ESD cover from JFP 121210 J11 Mate JFP SIH 121210 P11 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓
69	Remove and store ESD cover from JFP 121210 J12 Mate JFP SIH 121210 P12 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓
70	Remove and store ESD cover from JFP 121210 J08 Mate JFP SIH 121210 P08 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓
71	Remove and store ESD cover from JFP 121210 J07 Mate JFP SIH 121210 P07 Measure FPU Isolation Resistance to OBA structure [R > 1MΩ] Perform torque of 0,33 Nm		✓

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No:	Activity	Remarks/Results	Sign off
72	Remove and store ESD cover from JFP121210 J03 Mate JFP P03 Measure FPU Isolation Resistance to OBA structure [R > 1M Ω] Perform torque of 0,33 Nm		✓
73	Remove and store ESD cover from JFP 121210 J04 Mate JFP SIH 121210 P04 Measure FPU Isolation Resistance to OBA structure [R > 1M Ω] Perform torque of 0,33 Nm		✓
74	Record mate/demate activities in paper EIDP log Verification of Instrument Grounding	Record in E-PLM Mating / Demating DB too	
75	Remove SPIRE Safing Plug Type-V from CVV FTTHR 211121 J26		✓
76	Remove SPIRE Safing Plug Type-VI from CVV FTTHR 211121 J32		✓
77	Remove SPIRE Safing Plug Type-VIII from CVV FTTHR 211121 J30		✓
78	Remove SPIRE Safing Plug Type-VIII from CVV FTTHR 211121 J29		✓
79	Prepare a 128-way BOB with short contacts & mate Short-plug to remove charge		✓
80	Mate BOB to CVV FTTHR 211121 J32		✓
81	Demate BOB Short-plug		✓
82	Verify FPU Isolation from OBA by measuring Pin 5 to Chassis: s.b. > 1 MOhm		OC
83	Verify Analogue Ground Isolation from OBA by measuring Pin 93 to Chassis: s.b. > 1 MOhm		OC
84	Demate BOB from CVV FTTHR 211121 J32		✓
85	Prepare a 128-way BOB and with short contacts & mate Short-plug to remove charge		✓
86	Demate BOB Short-plug		✓
87	Mate BOB to CVV FTTHR 211121 J26		✓
88	Verify FPU Isolation from OBA by measuring Pin 2 to Chassis: s.b. > 1 MOhm		OC
89	Verify Analogue Ground Isolation from OBA by measuring Pin 36 to Chassis: s.b. > 1 MOhm		OC

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No:	Activity	Remarks/Results	Sign off
90	Demate BOB from CVV FTHR 211121 J26		✓
91	Mate SPIRE Safeing Plug Type-V to CVV FTHR 211121 J26		✓
92	Mate SPIRE Safeing Plug Type-VI to CVV FTHR 211121 J32		✓
93	Mate SPIRE Safeing Plug Type-VIII to CVV FTHR 211121 J30		✓
94	Mate SPIRE Safeing Plug Type-VIII to CVV FTHR 211121 J29		✓
95	Perform final screw-lock fixation " prior flight "		✓
96	PA to perform final FPU & JFET SIH inspection	To be completed later 30.10.07	✓
97	ASED final inspection of SPIRE Cold-unit & SIH integration	30.10.07	✓
98	RAL final inspection of SPIRE Cold-unit & SIH integration		✓
99	AAS-F final inspection of SPIRE Cold-unit & SIH integration	30.10.07	✓
100	ESA final inspection of SPIRE Cold-unit & SIH integration	30.10.07	✓
	End of step by step procedure - CVV internal part		✓

30.10.07 final inspection before OBS closure see Logbook SVH

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SPIRE FPU SIH I/F-Connectors (RD-3)

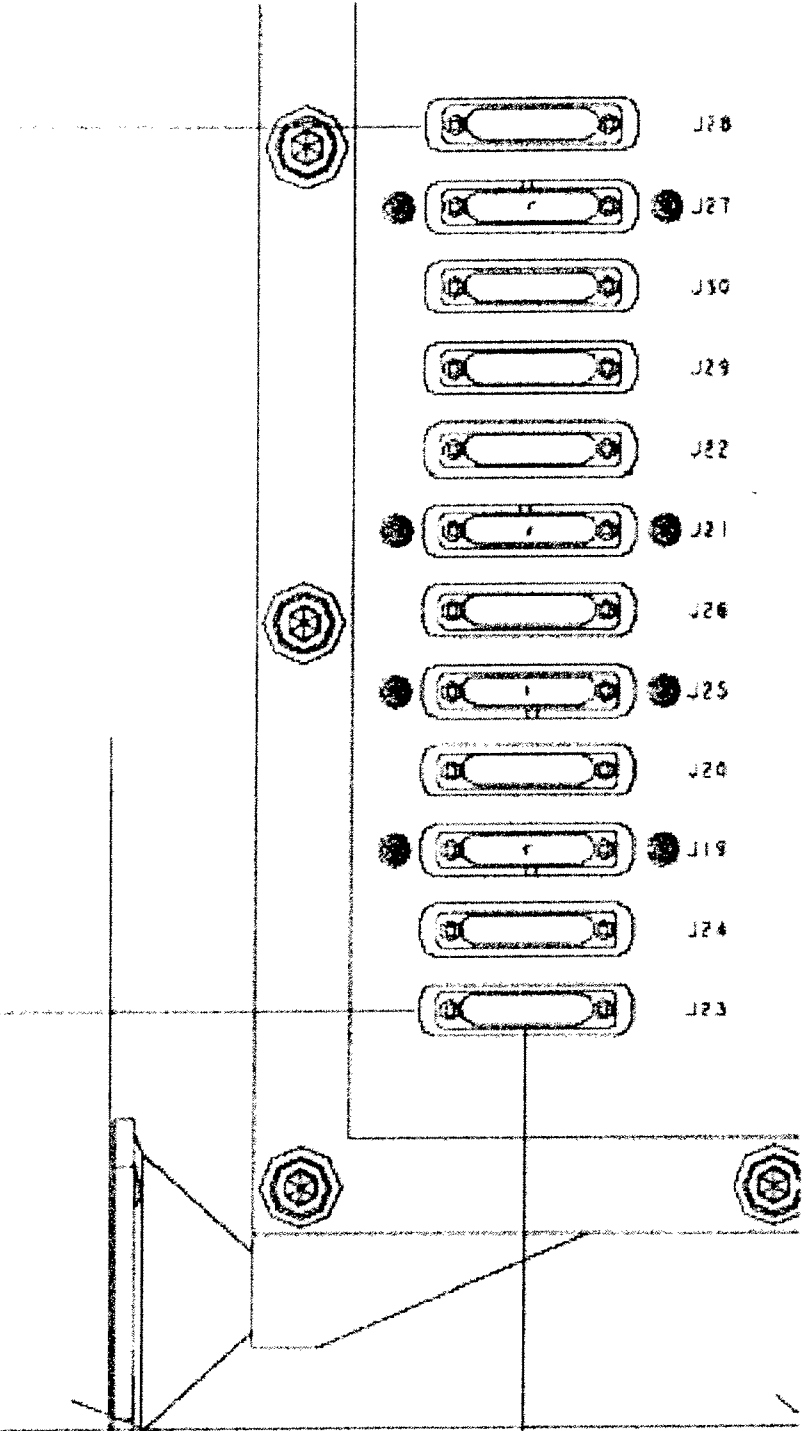


Figure 10.4.2 SPIRE FPU SIH I/F Connectors

SPIRE JFS SIH I/F-Connectors (RD-3)

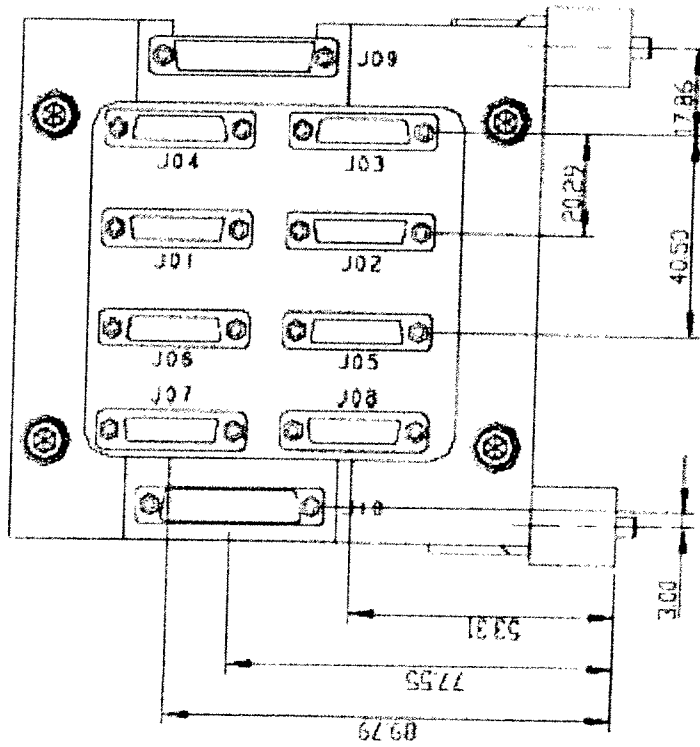


Figure 10.44: SPIRE JFS SIH I/F Connectors

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SPIRE JFP SIH I/F-Connectors (RD-3)

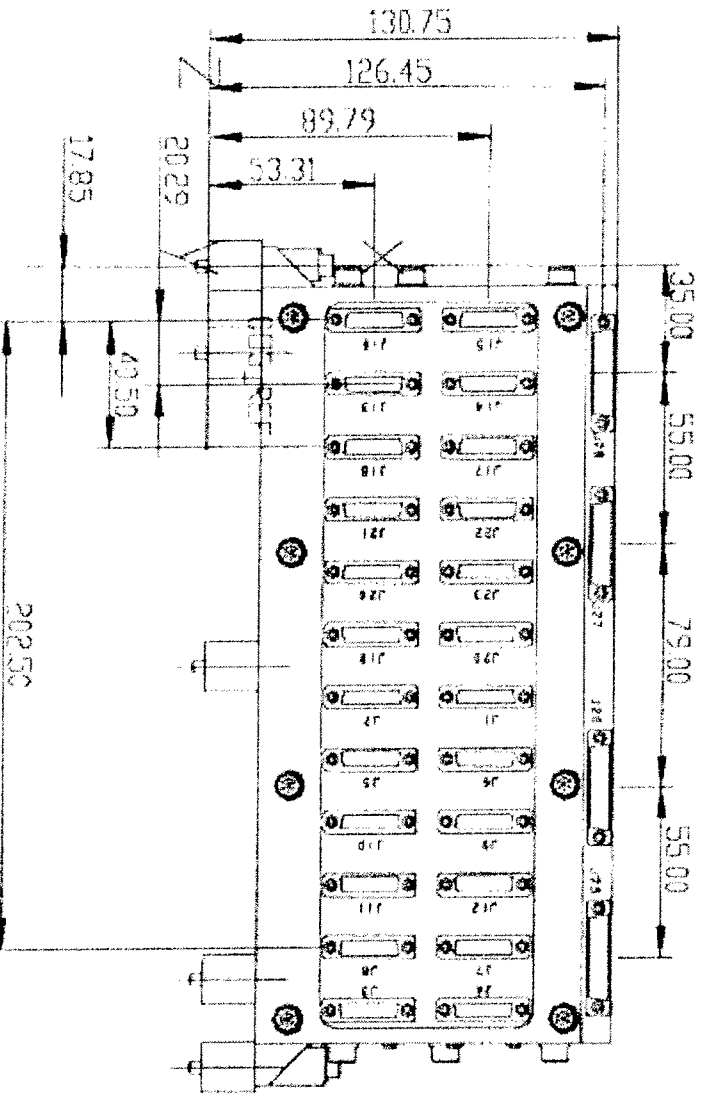


Figure 19-4-6: SPIRE JFP SIH I/F Connectors

End of CVVint SPIRE PFM FPU, JFET & SIH Electrical Integration Procedure

4. APPENDIX 1 – EADS INTEGRATION SEQUENCE EMAIL

From: Idler, Siegmund [Siegmund.Idler@astrium.eads.net]

Sent: 20 March 2007 16:50

To: Sawyer, EC (Eric)

Cc: Bernard.Collaudin@alcatelaleniastpace.com; Guy.Doubrovik@alcatelaleniastpace.com; Benoit.Gobillot@alcatelaleniastpace.com; King, KJ (Ken); Griffin, DK (Doug);

'carsten.scharmberg@esa.int'; Mueller, Martin; Koppe, Axel; Sonn, Nico; Schink, Dietmar

Subject: Instruments El. Integration Flow

Dear Eric,

as agreed during the SPIRE DRB, please find below the instruments electrical integration sequence as currently discussed as option. The major difference to the previous planning is, that - for schedule recovery reasons - the CVV-SVM preliminary mating is cancelled and the first warm test with the integrated instrument is with the evacuated warm CVV. However, the ESA/AAS-F instruction to follow this option is still outstanding! Nevertheless, could you please base your procedures to be delivered on this option since it is the most likely one to be followed.

Activities on SVM

1. Integrate WIH on SVM (already done)
2. Integrate WU on SVM
3. Connect WIH to WU
4. Perform el. integration tests of WU
5. Perform WU functional test (via CCS)
6. Close panel

Activities on EPLM

7. Integrate FPU on OBA
8. Integrate CVV ext. SIH (and connect SIH to CVV feed throughs)
9. Install termination plugs on open ends of CVV ext. SIH (on SVM CB side)
10. Connect SIH to FPU
11. Perform stand alone test with HIFI FPU (using the FCU EQM)
12. Close and evacuate CVV

Activities on S/C

13. Mate CVV with SVM
14. Connect WU to FPU (remove termination plugs and mate SIH at SVM CB)
15. Perform instrument warm functional test

Note: Only those activities are listed which are related to the instrument electrical integration and which support the understanding of it.

Regards

Siegmund

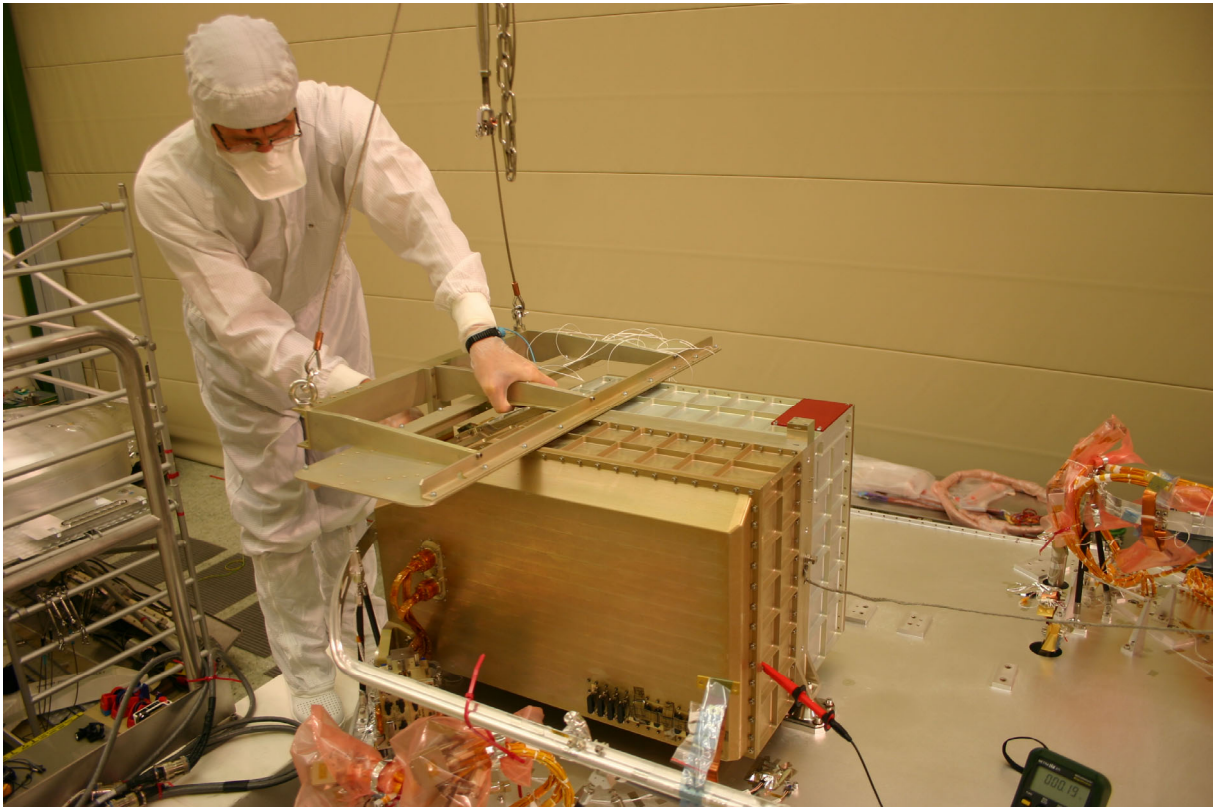


Figure 1: SPIRE FPU Integration Preparation



Figure 2: SPIRE FPU in flight to its position

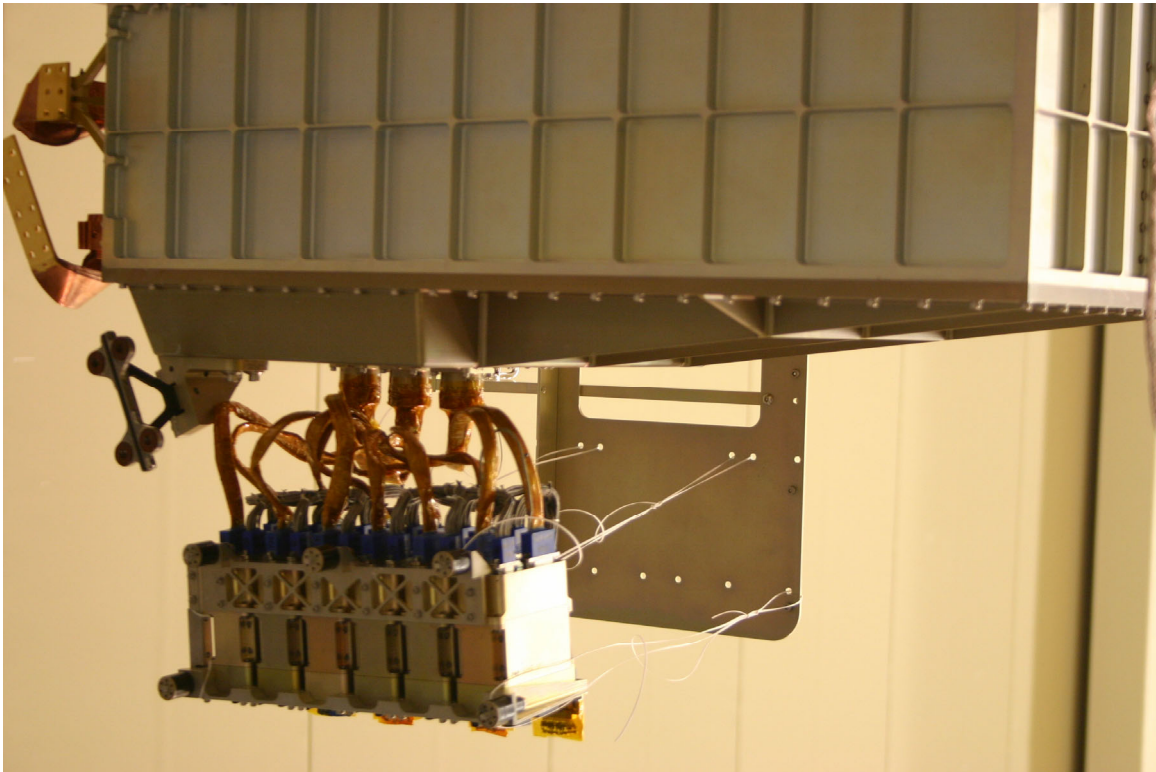


Figure 3: Photometer JFET assembly



Figure 4: Integration on OBP

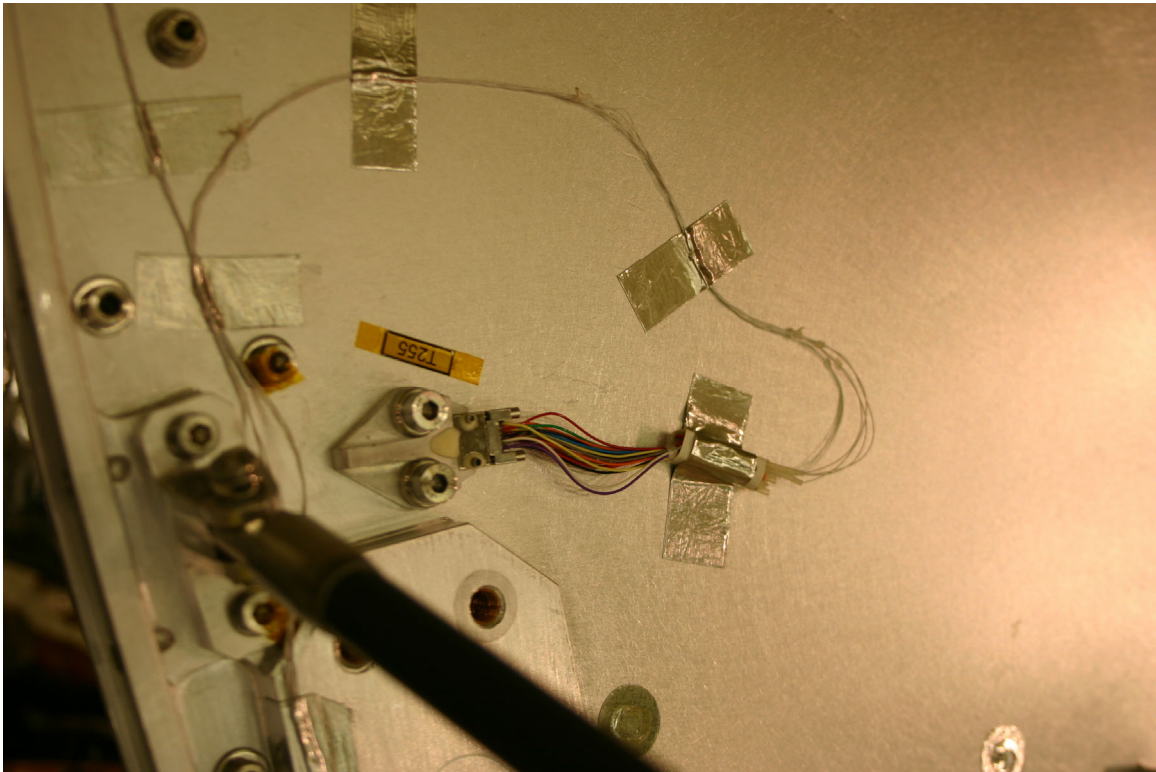


Figure 5: Temperature Sensor T255

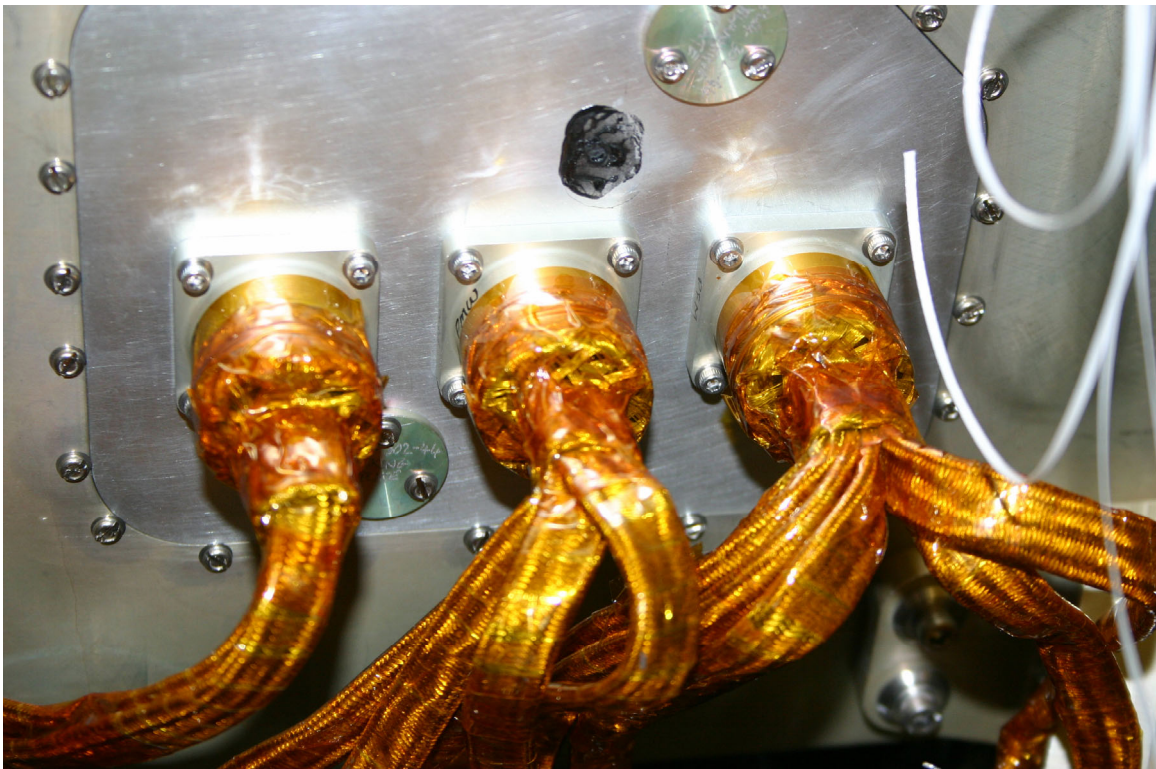


Figure 6: JFET Harness connectors HS PLW, HS PMW and HS PSW of SPIRE Photometer

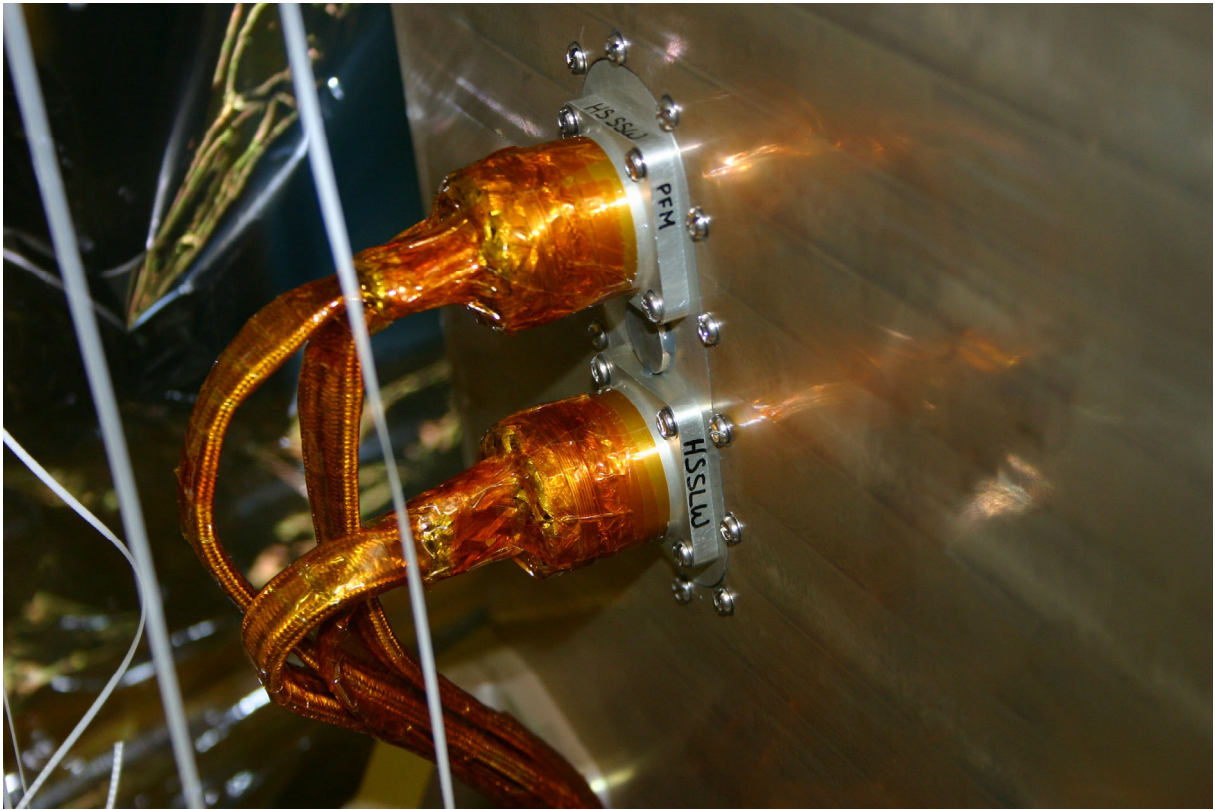


Figure 7: JFET Harness connectors HS SSW and HS SLW of SPIRE Spectrometer

END OF DOCUMENT

	Name	Dep./Comp.		Name	Dep./Comp.
	Baldock Richard	FAE12		Schweickert Gunn	ASG23
	Barlage Bernhard	AED13	X	Sonn Nico	ASG51
X	Bayer Thomas	ASA42		Steininger Eric	AED321
	Brune Holger	ASA45	X	Stritter Rene	AED11
	Chen Bing	HE Space		Suess Rudi	OTN/ASA44
	Davis William	Captec		Theunissen Martijn	DSSA
	Edelhoff Dirk	AED21		Vascotto Riccardo	HE Space
	Fehringer Alexander	ASG15		Wagner Klaus	ASG23
X	Fricke Wolfgang Dr.	AED 65	X	Wietbrock Walter	AET12
X	Geiger Hermann	ASA42		Wöhler Hans	ASG23
X	Grasl Andreas	OTN/ASA44		Wössner Ulrich	ASE252
	Grasshoff Brigitte	AET12		Zumstein Armin	AED15
	Hamer Simon	Terma			
	Hanka, Erhard	FI522			
	Hendrikse Jeffrey	HE Space			
X	Hendry David	Terma			
	Hengstler Reinhold	ASA42			
	Hinger Jürgen	ASG23			
	Hohn Rüdiger	AED65			
	Hopfgarten Michael	AET32			
	Huber Johann	ASA42			
	Hund Walter	ASE252			
X	Idler Siegmund	AED312			
	Ivány von András	FAE12			
	Jahn Gerd Dr.	ASG23	X	ESA/ESTEC	ESA
	Jolk Matthias	AET1	X	Thales Alenia Space Cannes	TAS-F
	Klenke Uwe	ASG72		Thales Alenia Space Torino	TAS-I
	Kölle Markus	ASA43			
	König Werner	AET32			
X	Koppe Axel	AED312		Instruments:	
X	Kroeker Jürgen	AED65		MPE (PACS)	MPE
	La Gioia Valentina	Terma	X	RAL (SPIRE)	RAL
X	Lang Jürgen	ASE252		SRON (HIFI)	SRON
	Langenstein Rolf	AED15			
X	Langfermann Michael	ASA41			
	Leitermann Stefan	AET12		Subcontractors:	
	Liberatore Danilo	Rhea		Austrian Aerospace	AAE
	Martin Olivier	Altec		Austrian Aerospace	AAEM
	Maukisch Jan	ASA43		BOC Edwards	BOCE
	Much Christoph	ASA43		Dutch Space Solar Arrays	DSSA
	Müller Martin	ASA43		EADS Astrium Sub-Subsyst. & Equipment	ASSE
	Pietroboni Karin	AED65		EADS CASA Espacio	CASA
X	Reichle Konrad	ASA42		EADS CASA Espacio	ECAS
	Runge Axel	OTN/ASA44		European Test Services	ETS
	Saal Christoph	External		Patria New Technologies Oy	PANT
	Schink Dietmar	AED321		SENER Ingenieria SA	SEN
	Schmidt Thomas	AED15		Thales Alenia Space, Antwerp	TAS-ETCA